

MPGD - ECT

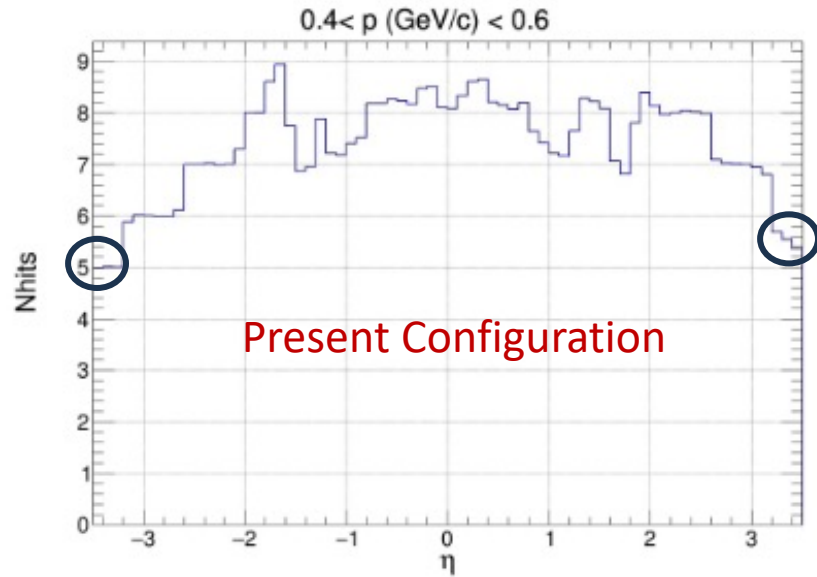
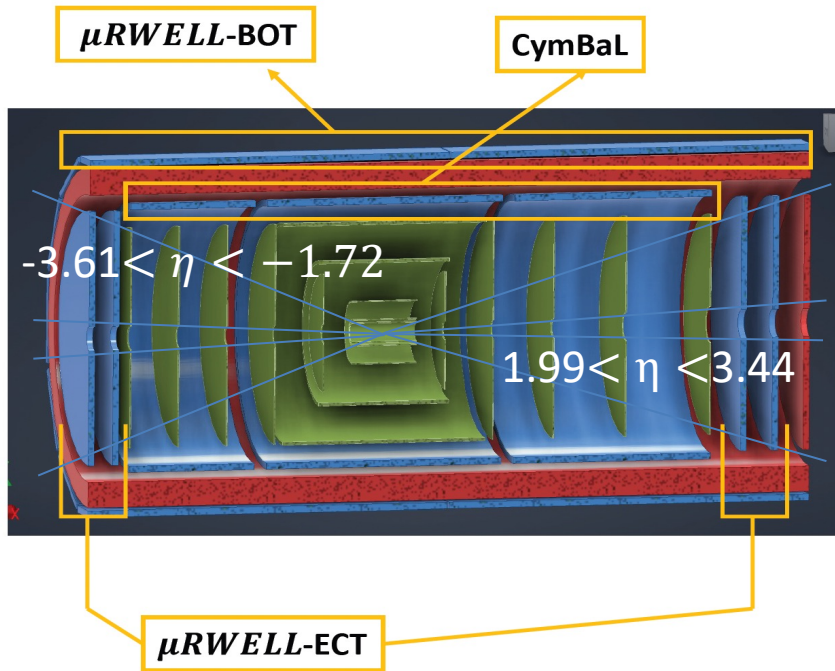
μ - Rwell endcap trackers for the EPIC detector at EIC

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Scope of the MPGD endcaps in ePIC detector tracking

- Adding **two MPGD Endcap Tracking (ECT) disks** both in the **hadronic** and in the **leptonic regions** increased the number of hits in the $|\eta| > 2$ region to improve pattern recognition.



Present ePIC tracker geometry

Time resolution 10 ns or less to provide tracking timing

- Fast rise time $\sim 20 \div 50$ ns
- Peaking time 50 ns
- Sampling faster than 50 MHz

Low material budget

- 1-2 % X_0 - it will be the minimum compatible with the chosen technology

Spatial resolution: 150 μm or better

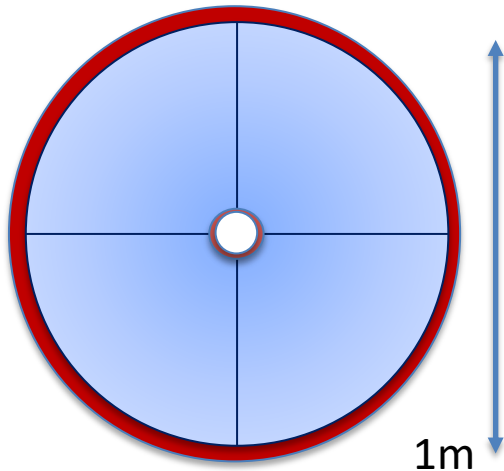
- $<150 \mu\text{m}$ intrinsic spatial resolution for perpendicular tracks
- Technological optimizations to retain 150 μm resolution for inclined/curved tracks

High Efficiency

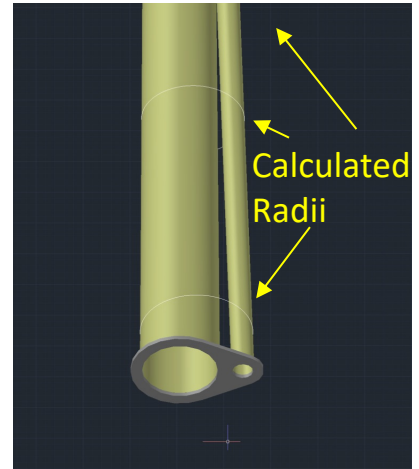
- Single detector efficiency $\sim 96 - 97$ % $\rightarrow 92 - 94$ % combined efficiency for two disks

Detector Geometry: Envelope and Active Regions

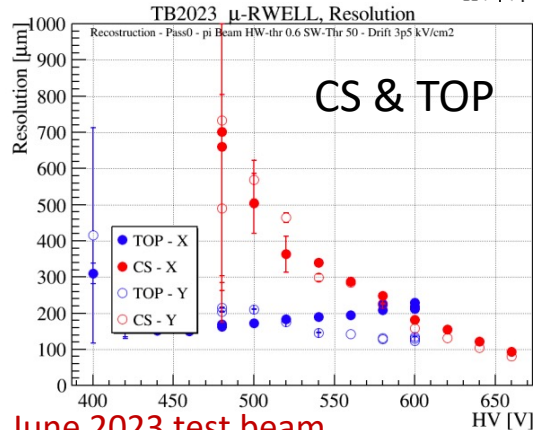
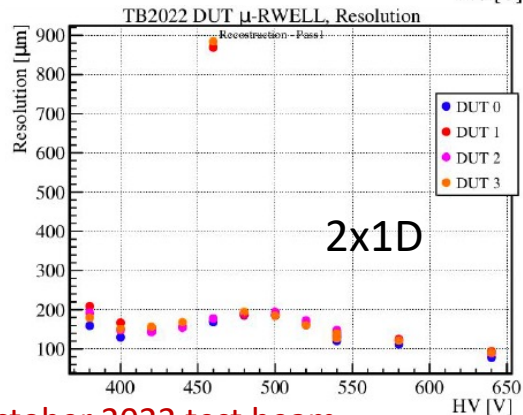
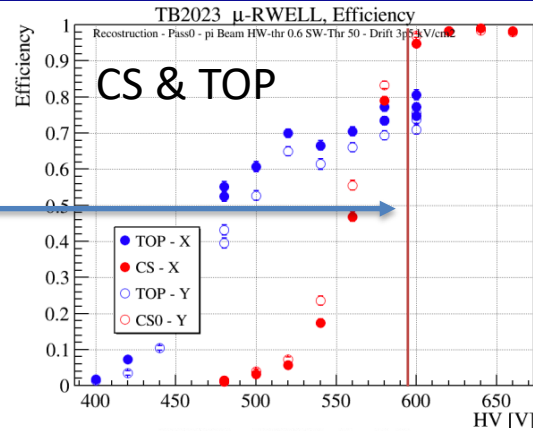
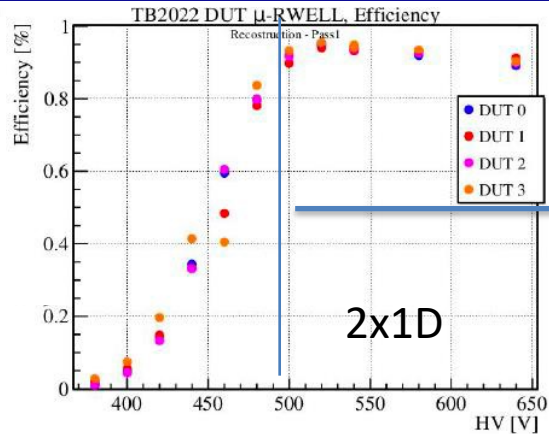
MPGD Disk	Max Z Pos (cm)	Disk Outer Radius (cm)	Outer Active Reg. radius (cm)	Calculated Beam pipes radii (mm)	Offset (mm)	Disk Inner Radius (cm)	Inner Active Reg. radius (cm)
HD MPGD 2	163.5	50	45	55.8	22.5	9	10.5
HD MPGD 1	150.5	50	45	53.1	19.9	9	10.5
LD MPGD 1	-112.5	50	45	37.7	-3.1	4.5	6.0
LD MPGD 2	-122.5	50	45	39.2	-3.4	4.5	6.0



- Two couples of disks: Lepton/Hadron Disks
- The geometric envelope should include the electronics front-end boards
- 50 cm external radius/45 cm active region radius – including 5cm outer ring for services.
- Different internal hole dimensions due to divergent beam pipes: 4.5 cm (LD)/9 cm(HD)



MPGD Technology - 2-D Tracking layout tests



October 2022 test beam

June 2023 test beam

1D pitch 0.78 mm

Reference performances:

- 96% efficiency
- 120 μ m resolution

CS pitch 1.2mm

- Due to the charge spread the working point is shifted to high voltage/gain
- Spatial resolution improves at high gain reaching 150 μ m with a strip pitch of 1.2 mm

Top-r/out pitch 0.78 mm

- low-voltage/gain operation but low efficiency level (80%) due to the geometrical dead zone on the segmented amplification stage

Nuclear Inst. and Methods in Physics Research, A 936 (2019) 401–404

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Development of μ -RWELL detectors for the upgrade of the tracking system of CMD-3 detector

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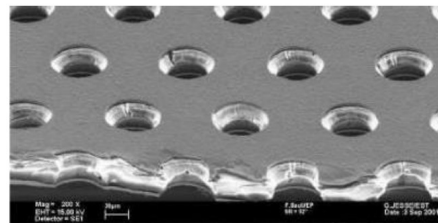
ABSTRACT

An upgrade of tracking system of Cryogenic Magnetic Detector (CMD-3) is proposed using microresistive WELL technology. CMD-3 is a general purpose detector operating at the VEPP-2000 collider at Budker Institute of Nuclear Physics and intended for studies of light vector mesons in the energy range between 0.3 GeV and 2 GeV. The new subsystem consists of double-layer cylindrical detector and the end-cap discs. Two prototypes, micro-RWELL and micro-RWELL-GEM were built and tested. Gas amplification of micro-RWELL detector was measured with several gas mixtures and maximum gain between 20000 and 30000 was observed. However, maximum gain is fluctuating from measurement to measurement by a factor of 2 and thus a safety margin of 2–3 is needed to provide reliable operation of the device. In order to increase the signal GEM was added to micro-RWELL, new prototype was tested with the same gas mixtures and gains above 10^5 have been demonstrated. Time resolution achieved for both prototypes are 7 ns for micro-RWELL and 4 ns for micro-RWELL-GEM.

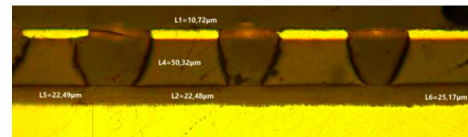
L. Shekhtman, Nuclear Inst. and Methods in Physics Research, A 936 (2019) 401–404



Drift Gap: Shekhtman 3mm – LNF+Roma2 6mm



Transfer Gap: Shekhtman 3mm – LNF+Roma2 3mm



Developed for **CMD3 upgrade disks** (4 sectors 50×50cm²)

The GEM **must be** stretched: sizes larger than 50×50cm² could be critical (depending on the gas gaps size).

L. Shekhtman, Nuclear Inst. and Methods in Physics Research, A 936 (2019) 401–404

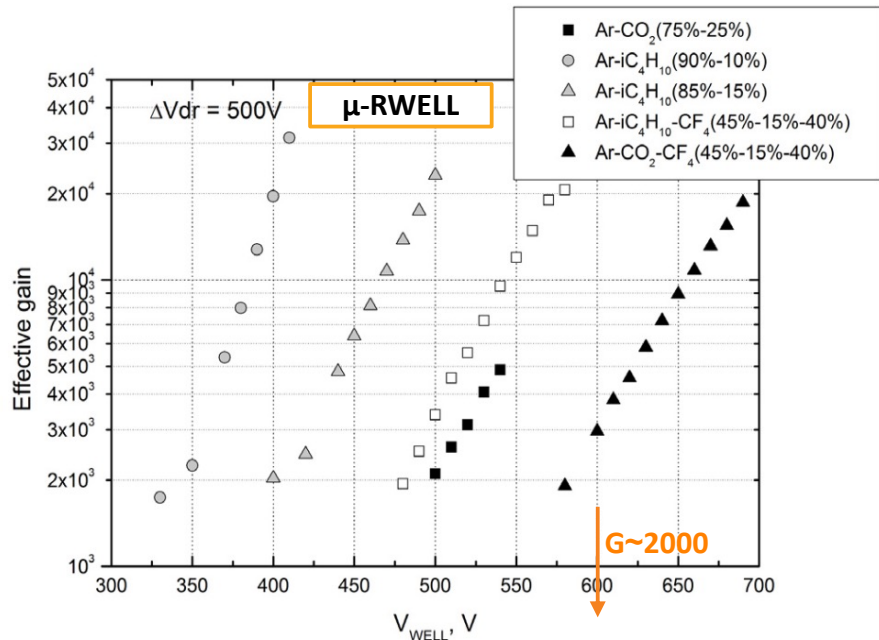


Fig. 4. Gain as a function of voltage on the top electrode of μ -RWELL for different gas mixtures. Voltage across the drift gap is 500 V.

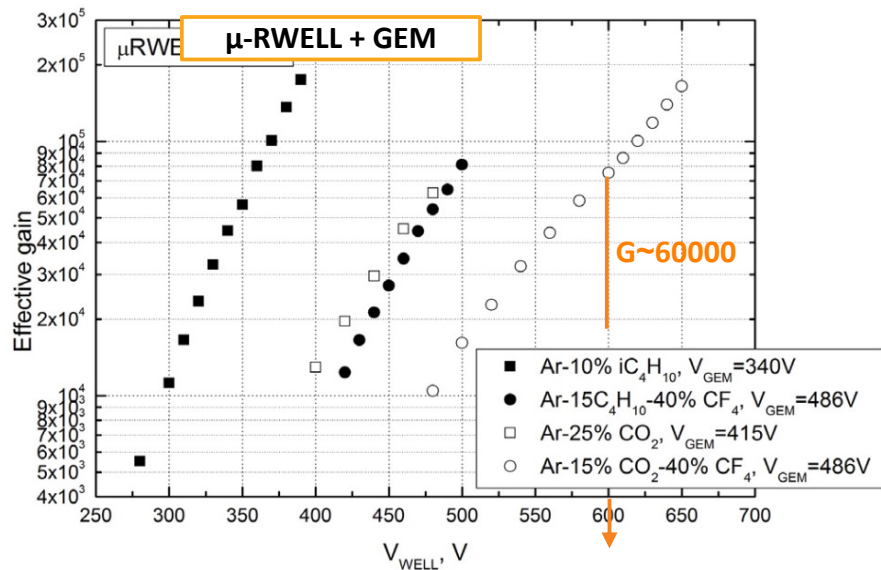
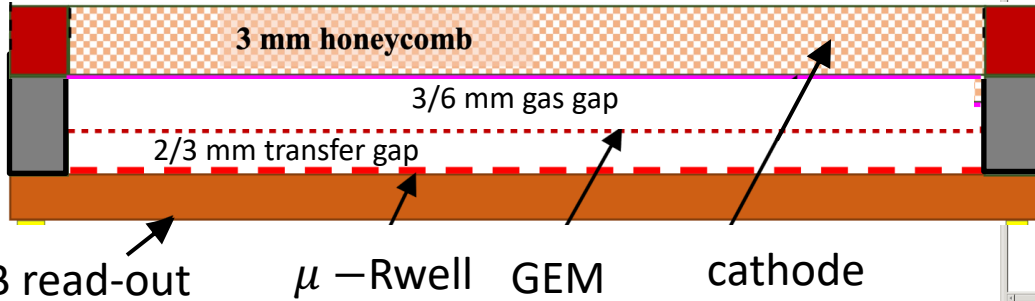


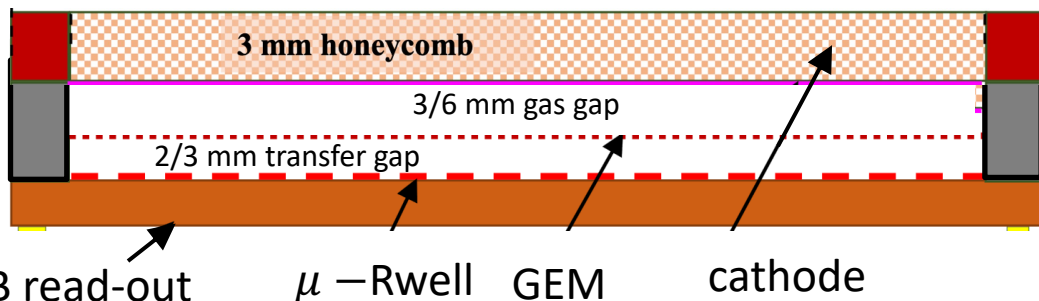
Fig. 5. Gain as a function of voltage on the top electrode of μ -RWELL for GEM voltages providing additional gain of 50–100 and for different gas mixtures. Voltage across the drift gap is 500 V.

GEM - μ Rwell Technology

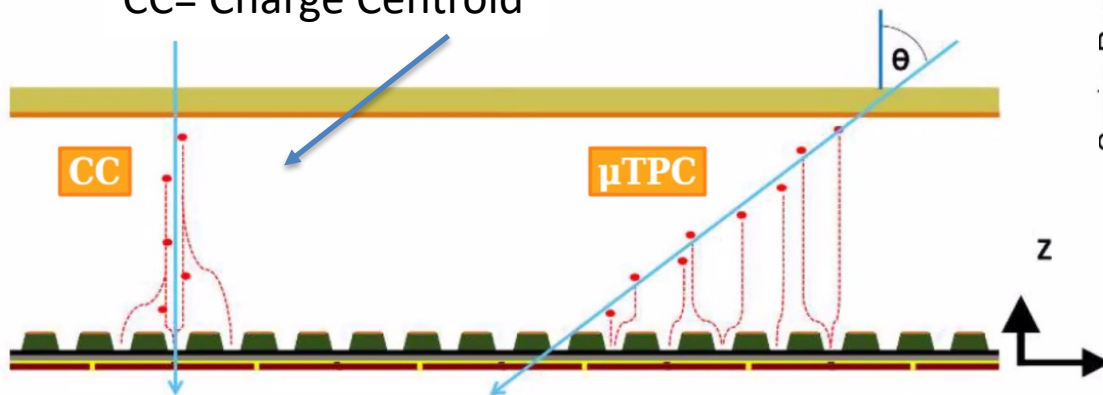


- 2D CS readout reduces the **gain** from 10^4 to $3-4 \cdot 10^3$ → the detector stability is put at risk
- GEM- μ Rwell hybrid configuration has been chosen to increase the gain in the $10\,000 \div 20\,000$ range
- 2D strip read-out using a “COMPASS-like” scheme
- $500 \mu\text{m}$ pitch guarantees a spatial resolution better than $150 \mu\text{m}$ (no need of capacitive sharing))
- A gas gap larger than 3 mm is compatible with single detector efficiency larger than 96%

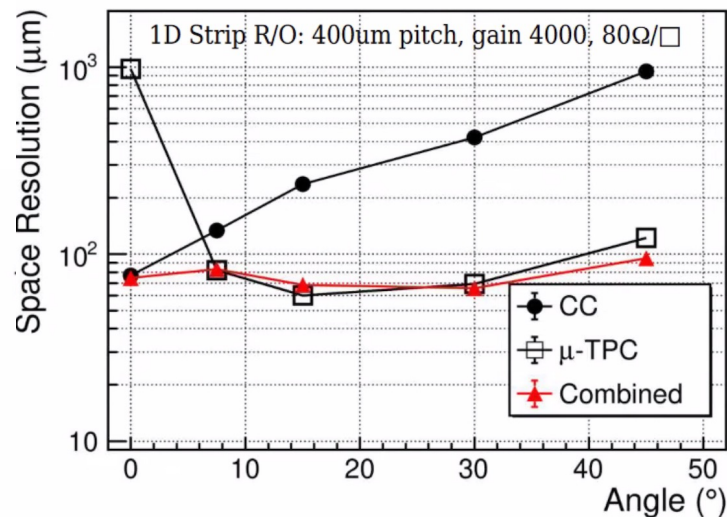
GEM - μ Rwell Technology



CC= Charge Centroid



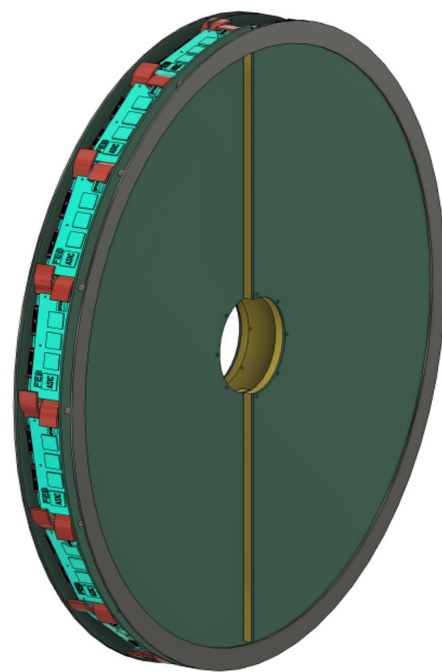
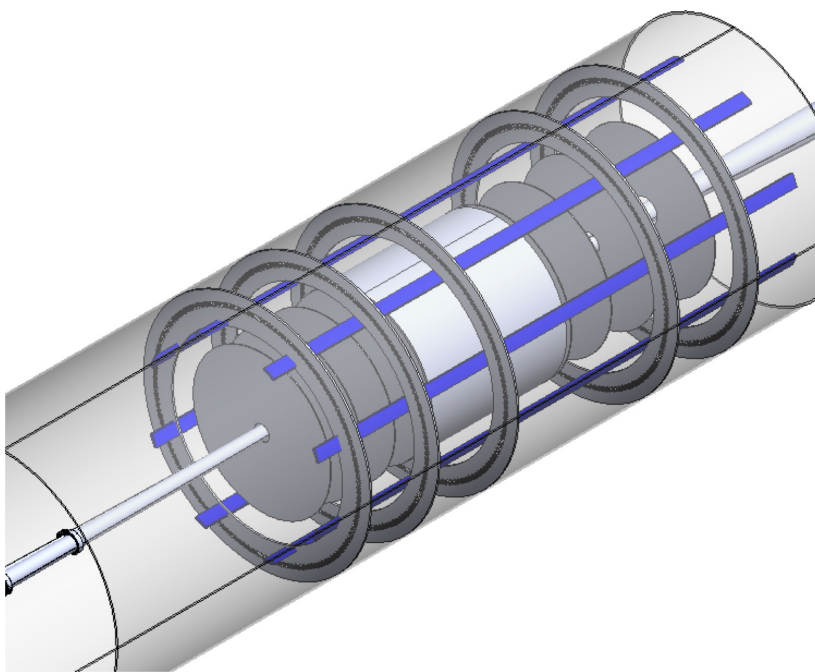
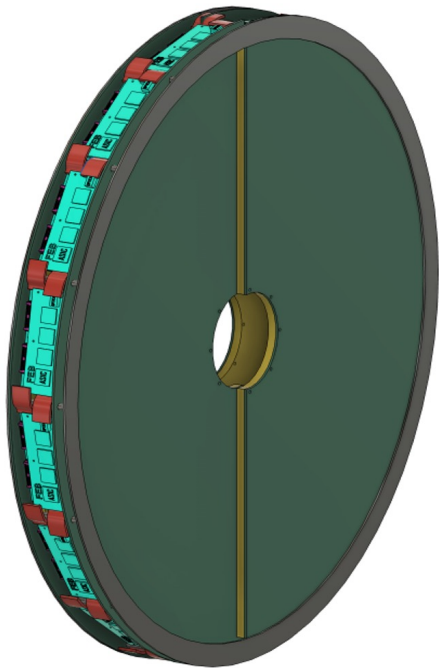
Combining the CC and μ TPC reconstruction (through a weighted average) a **resolution well below 100 μ m** could be reached over a wide incidence angle range.



Next test beam Oct/Nov 2024

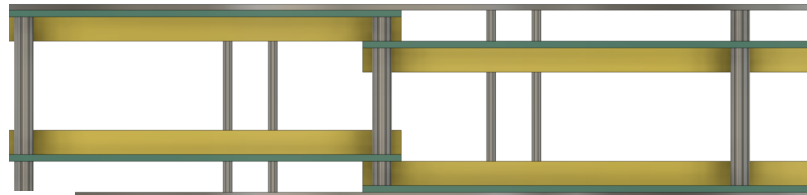
Endcap Detectors Integration in ePIC

The assigned envelope will include the detectors and the FEB electronics.
The disks will be attached together and to the support frame under design.

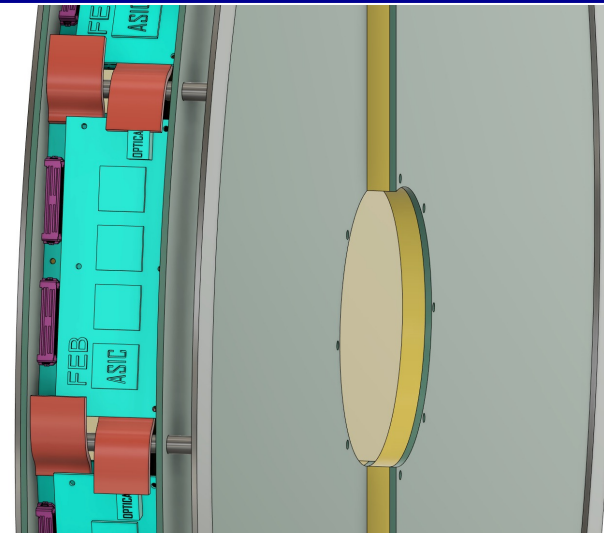


Endcap Detectors Mechanical design in progress

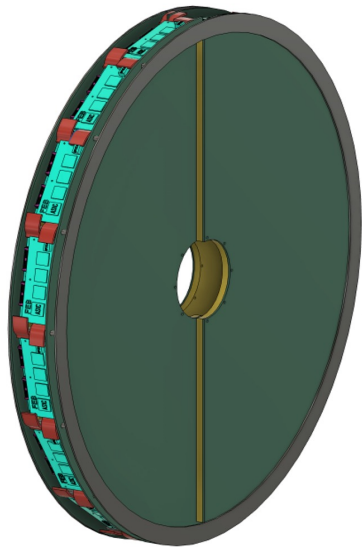
Longitudinal stack



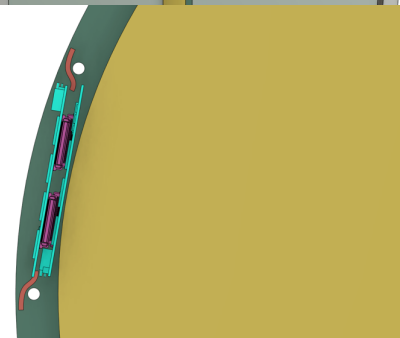
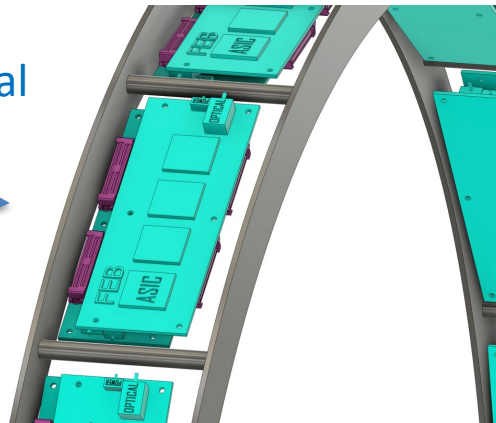
FEB mounting



Mechanical Support

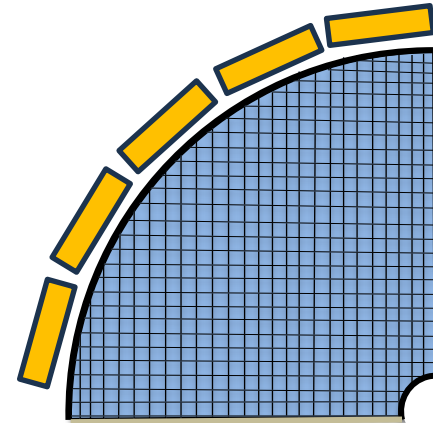


Connectors



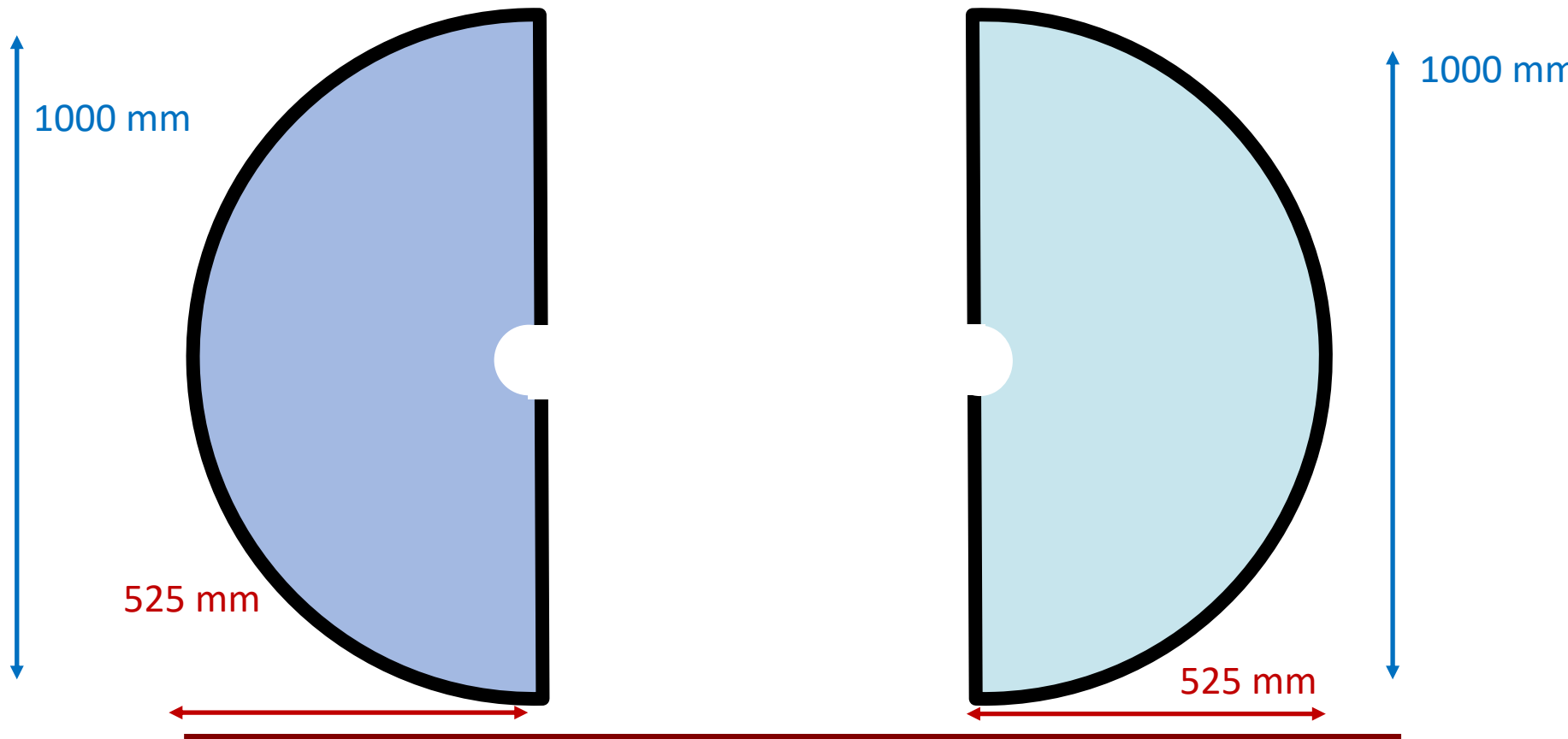
(X, Y) read-out geometry

PROs	CONs
The strip length does not vary much along the active area	Alignment is critical
All readout FE hybrids may be located outside the active area	Routes to read-out connectors must be accurately studied

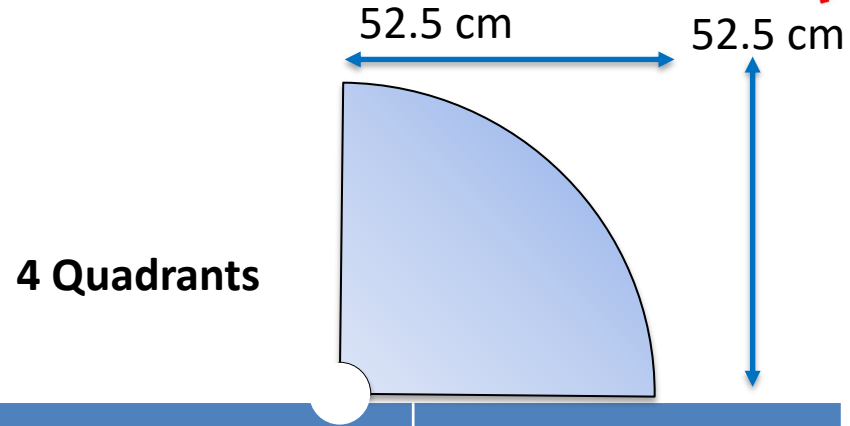
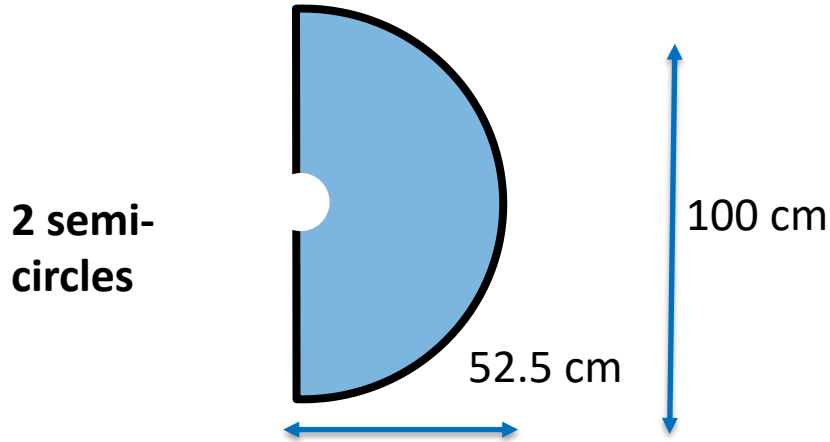


- (X, Y) readout is preferred vs (R,φ) – no FEB on the active area
- $500 \mu m$ pitch \rightarrow better than $150 \mu m$ intrinsic position resolution
 - **Strips routing details is being studied**

Detector Technology Choices: Detector sectors overlap



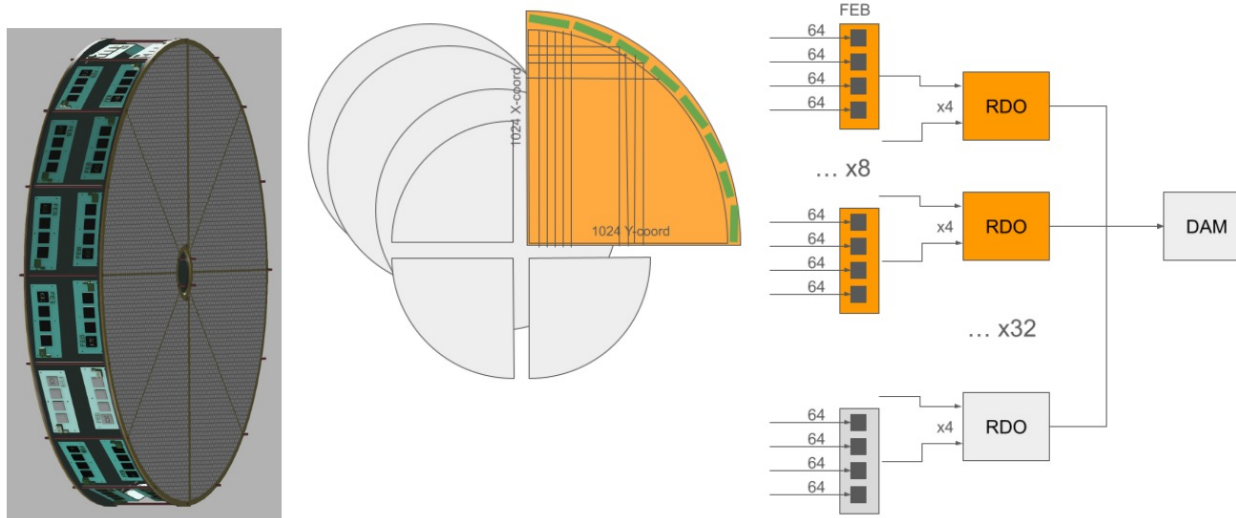
ePIC Endcaps – open options

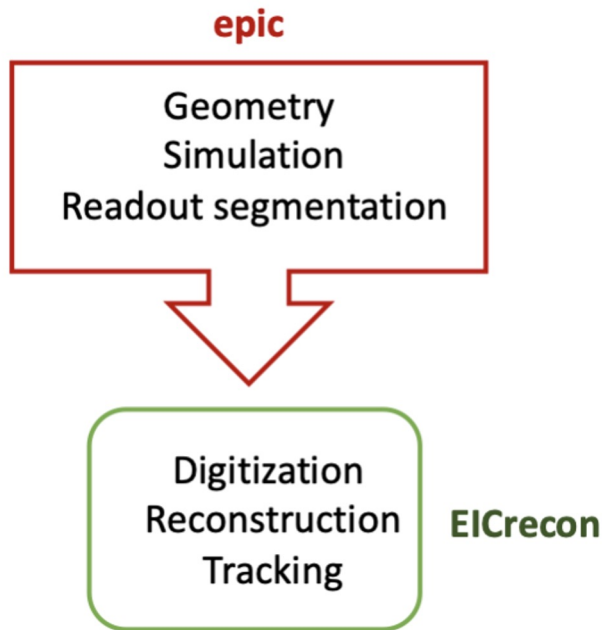


		PROs	CONs
	PROs	<p>Smaller dimensions are easier to handle</p> <p>Each endcap is intrinsically symmetric</p> <p>Strips length are shorter</p> <p>GEM foils easier to stretch</p>	<p>Two vertical and horizontal overlapping regions – more material budget</p> <p>We need to study how to attach two quadrants in a semi-circle</p>
	CONs	<p>Larger detector surfaces are more difficult to handle.</p> <p>Longer strips: → Readout should be segmented into two sectors to avoid too long strips</p> <p>GEM foils need to be supported</p>	<p>One vertical/horizontal overlap only – less material</p> <p>The two endcaps may be rotated by 90° one respect to the other to recover overall symmetry</p>

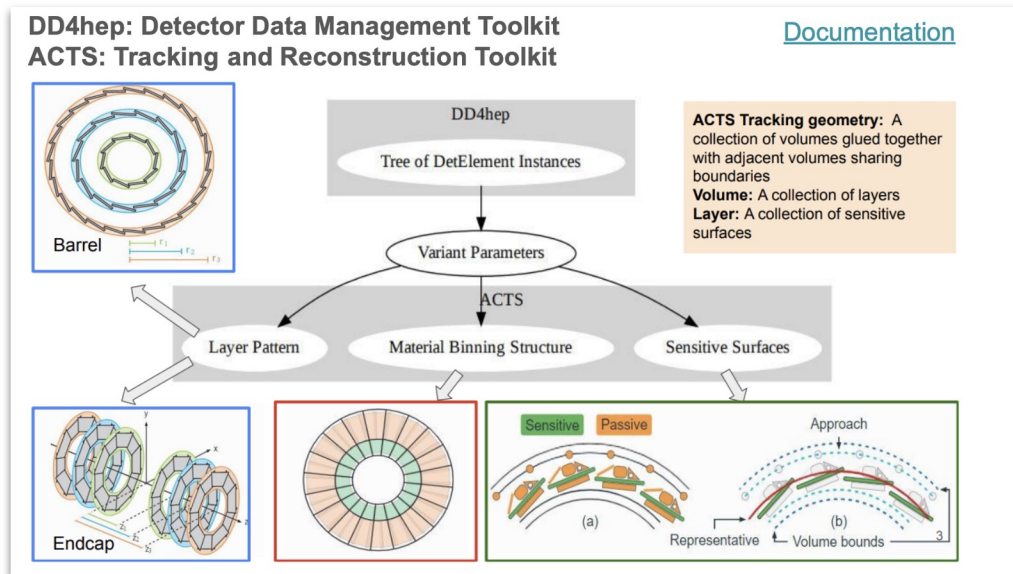
End Cap Tracker figures

- 4 disks each composed of 4 quadrants
- each quadrant has 1024 X-strip and 1024 Y-strip (2048 channels)
- assuming FE ASIC is 64 channels, grouped in 4 chips FEB, 4 to 1 connection FEB-RDO
- each quadrant will need 32 ASICs, 8 FEBs, 2 RDOs
- total amount is 32kChannels, 512 ASICs, 128 FEBs, 32 RDOs

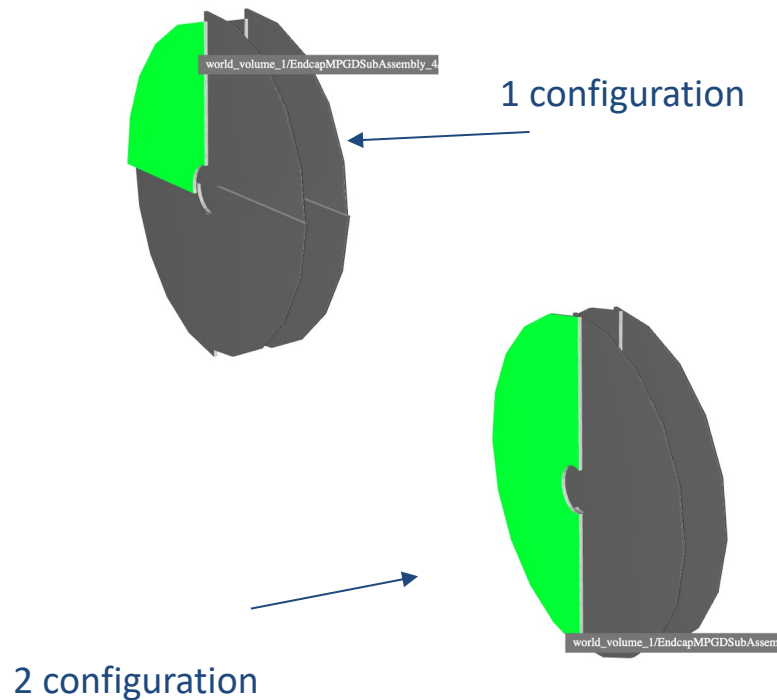




- ePIC geometry is based on DD4HEP
- ACTS is a toolkit for charge particle track reconstruction in hep experiments
- All digitization and reconstruction is done in EICrecon based on JANA



By Mariangela Bondi'



By Mariangela Bondi'

- Pairs of disk in electron and hadron endcaps based on uRWell technology
- 2 configuration under development:
 - 1 configuration : 4 quarters
 - 2 configuration: 2 semi-ellipses
- Currently disk made of subtracted solid
 - No overlaps
 - DD4hep-ACTS conversions fail
 - Disk approximation with trapezoid: working in progress

INFN Workforce:

- **Roma Tor Vergata – Also member of the DRD-1 WP1**

Coordinator: A. D'Angelo,

Detector Hardware and QA: E. Sidoretti (PhD) A. Fantini, L. Lanza, Post Doc

Simulation & Reconstruction: L. Lanza, A. Fantini, R. Di Salvo

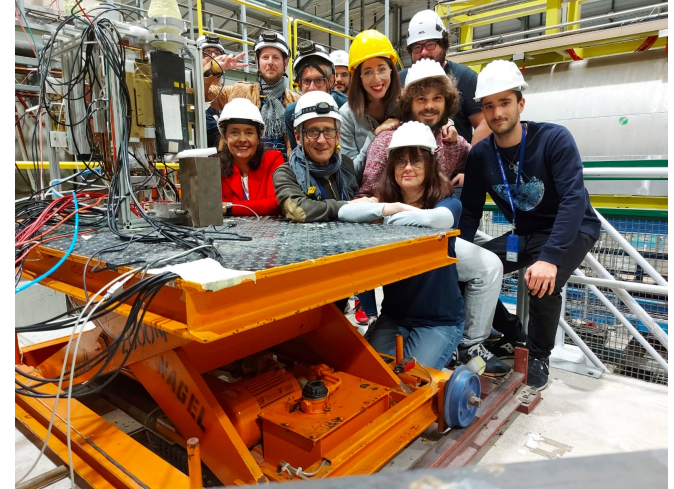
FEB Electronics: R. Ammendola

- **Genova**

FEB Electronics: Paolo Musico, M. Battaglieri (streaming ro)

- **Catania**

Simulation & Reconstruction: Mariagela Bondi'



INFN coordinates the GEM- μ Rwell MPGD ECT – for both the Hadron and Lepton Disks

- **INFN will provide the Hadron Disks and related electronics as In-kind contributions**
- **Temple U.** (Bernd Surrow , Matt Posik, ...) are interested taking the responsibility of the Lepton Disks.

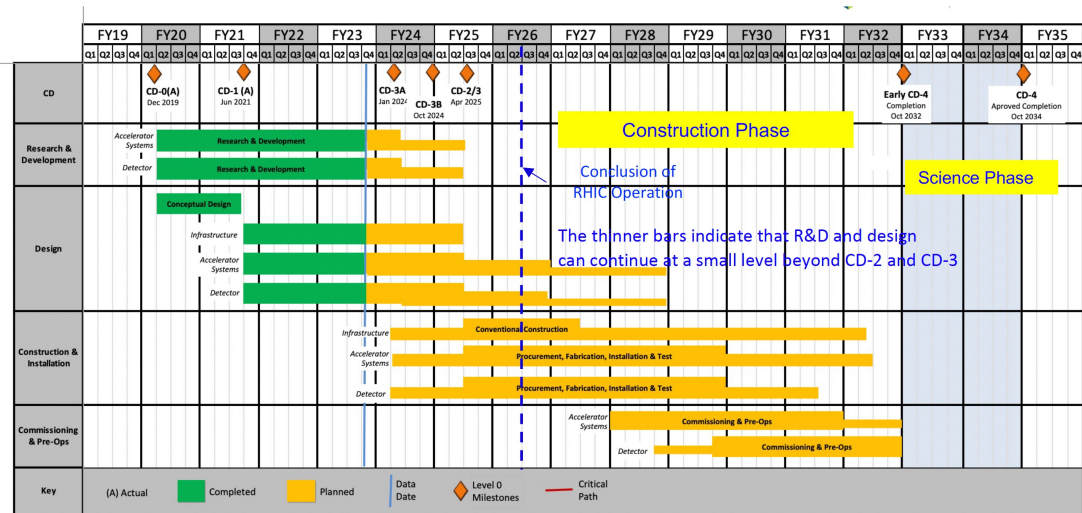
The is being performed in close connection with:

the group of **Gianni Bencivenni @ INFN LNF** and with the JLab detector group (**Kondo Gnanvo, Seung Joon Lee**)

Fabrication and Assembly Plans



- Design by end of 2024
- 2025 - 2026 Engineering Test Article and Pre-Production
- 2027 - 2029 production & QA
- 2030 Commissioning & Installation



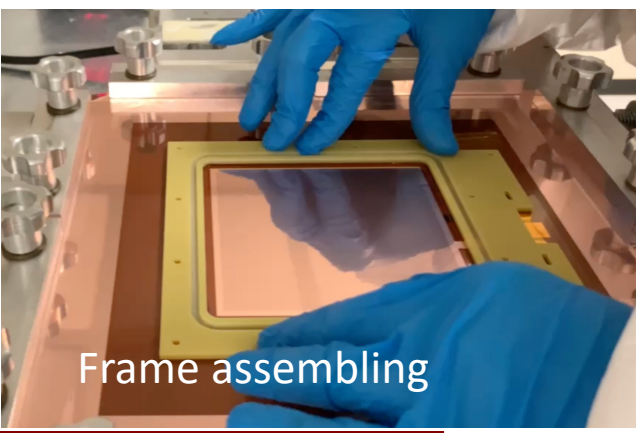
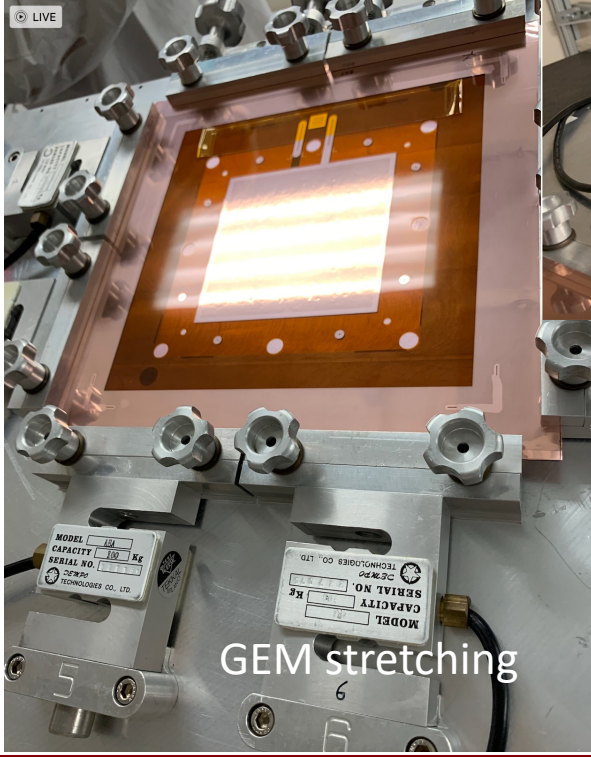
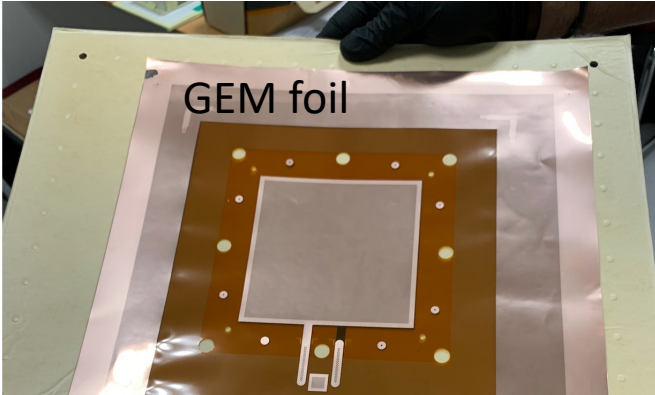
MPGD Timeline			DURATION (years)
START DATE	END DATE	DESCRIPTION	
3/1/24	12/31/24	Detectors Overall Design	<1
1/1/25	12/31/26	Pre - Production	2
1/1/27	31/12/29	Production & QA	3
1/1/30	6/1/30	Commissioning & Installation	0.5

On-going activities

First 10x10 cm² GEM- μ Rwell prototype – synergies with JLAB12



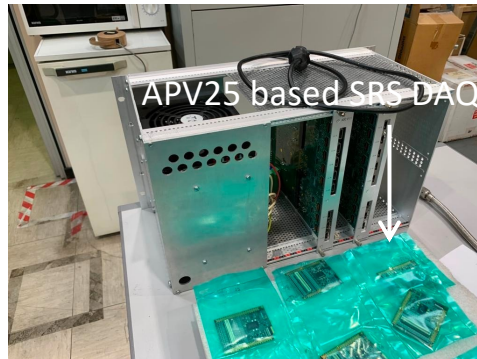
First GEM- μ Rwell 10x10 cm² prototypes assembly
CERN Test Beam – November 13 – 27 2024.



Infrastructures – synergies with JLAB12



The gas distribution system has been installed



APV25 based SRS DAO



Flow controller for gas mixtures



The gas mixture (Ar /CO₂/CF₄45%/15%/40%) and N₂ bottles are available



The oven and the CAEN HV supply are available

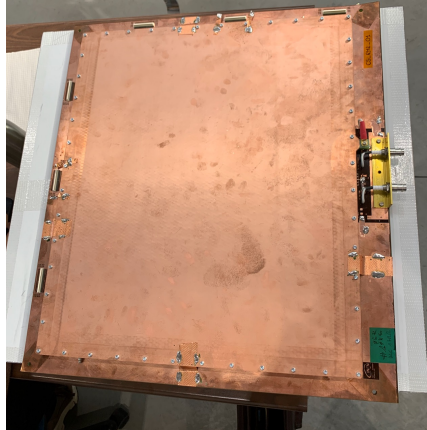


Megger Tester

- GEM layer for 50x50 cm² Large area detector with Capacitive sharing
- X-Ray gun and shielding
- GEM stretcher components

Test of Large Area Prototype steps @ LNF: CS - 40x46 cm²

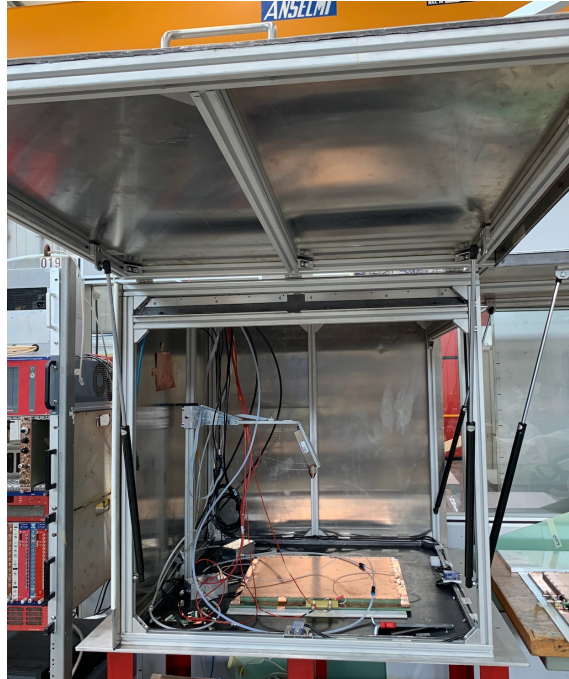
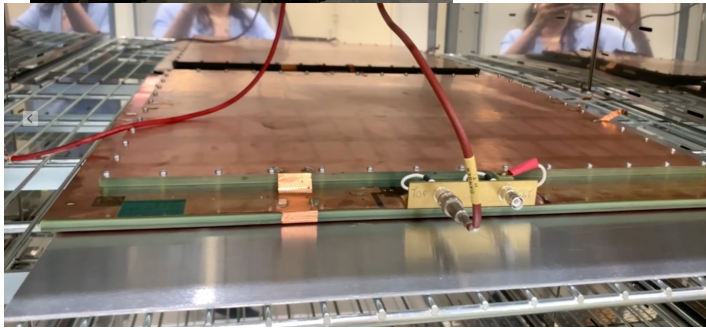
Data analysis is ongoing



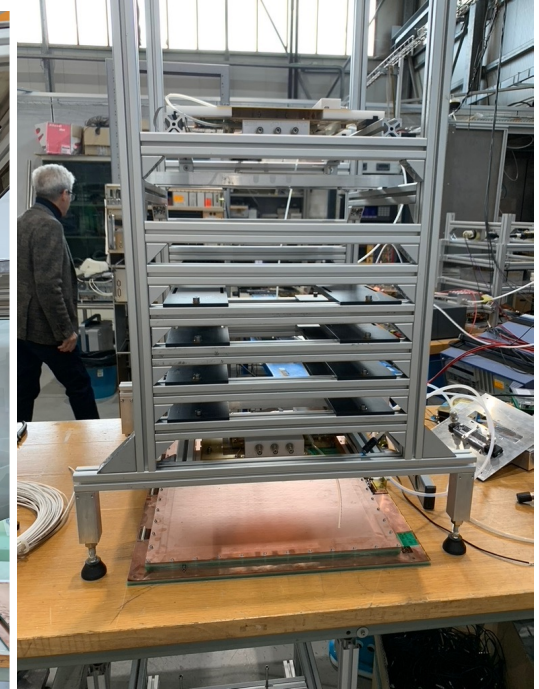
HV filter on



Conditioning
In the Oven



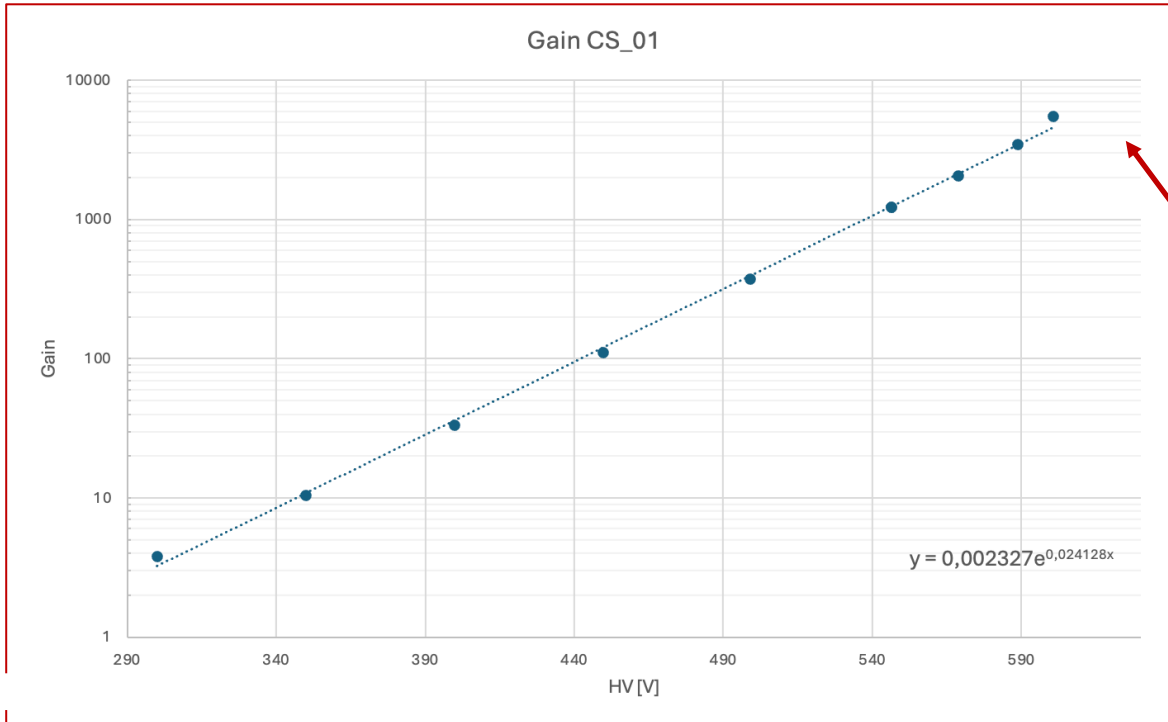
X-Ray characterization



Cosmic-rays Data Acquisition

Test of Large Area Prototype steps @ LNF: CS - 40x46 cm²

Data analysis is ongoing



First results confirm that maximum gain is ~ 6000

INFN- Workforce



Roma Tor Vergata		
Researchers	Position	FTE
Annalisa D'Angelo	P.O.	50%
Lucilla Lanza	RTDb	30%
Roberto Amendola	Tecnologo	20%
Alessia Fantini	Ric. Univ.	30%
Rachele Di Salvo	I Ric. INFN	10%
Bruno Benkel *	Assegnista Tec.	100%
Gaetano Salina	Dir. Ricerca INFN	20%
Karolina Armonaite	Assegn. altro ente	20%
Totale FTE		2.8

Catania		
Researchers	Position	FTE
Mariangela Bondì	Tecnologo	10%
Genova		
Researchers	Position	FTE
Marco Battaglieri	INFN DR	10%
Synergic JLAB12 techs		
Giovanni Nobili	Coll. Tecnico E.R. INFN	50%
Daniele Pecchi	Associazione Tecnica – UToV	30%
Enzo Reali	Incarico di Coll. Tecnica– UToV	30%
Enrico Maria Tusi	Incarico di Coll. Tecnica – UToV	30%
		1.4 FTE

*** A new experienced post-doc has been selected (DOE- PED2024)**

Thank you

Scope of the MPGD endcap trackers in the ePIC detector.

- Pseudo-rapidity coverage: effective η ranges
- Technical performance requirements
- Detector Geometry: Envelope and Active Regions
- Integration of MPGD endcap trackers in the ePIC detector

Detector technology

- 2D – readout challenges and test beam results
- Hybrid GEM- μ Rwell technology & μ TPC readout
- (X,Y) readout – 500 μ m pitch

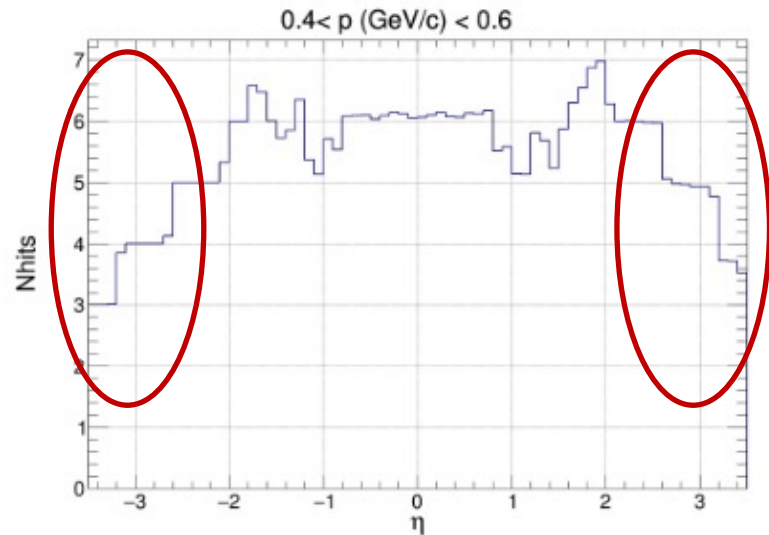
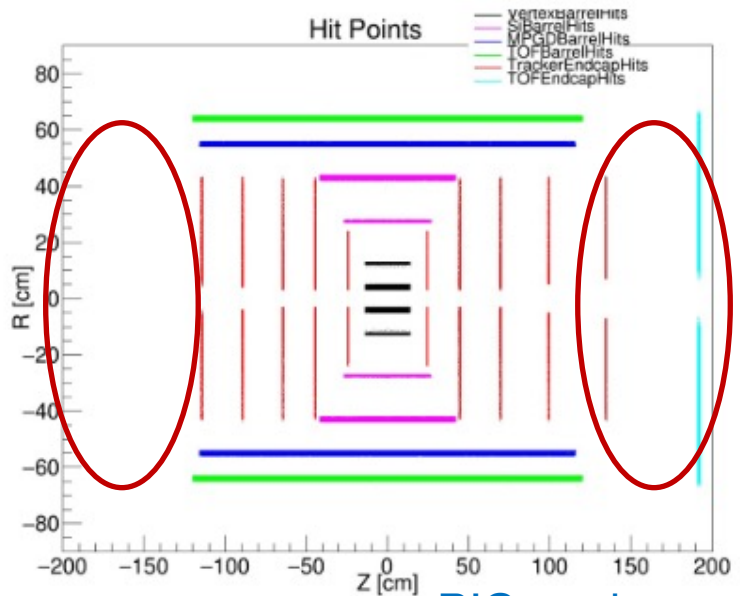
INFN Involvement

- Fabrication and Assembly Plans
- Timeline
- Workforce

Financial Plan and Requests to INFN

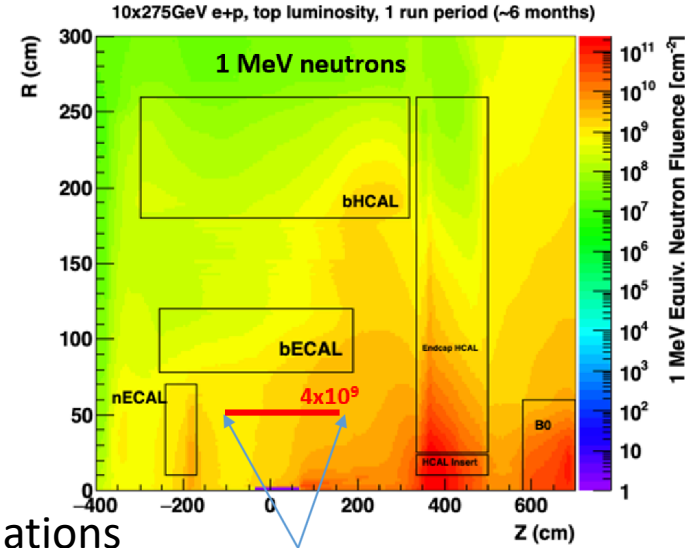
- Coordinate the MPGD endcap tracking project
- Complete the analysis of GEM- μ Rwell 10x10 cm² test beam data:
 - characterization of detector gain, efficiency and position resolution
- Study the detector response to bend/inclined tracks:
 - analysis of μ TPC mode in 2D
- Design and procure the first large area Engineering Test Articles
- Implement an emulator of the SALSA chip response to the GEM- μ Rwell detector
- Contribute to the TDR
- Organize the January 2025 ePIC General Meeting at Villa Mondragone

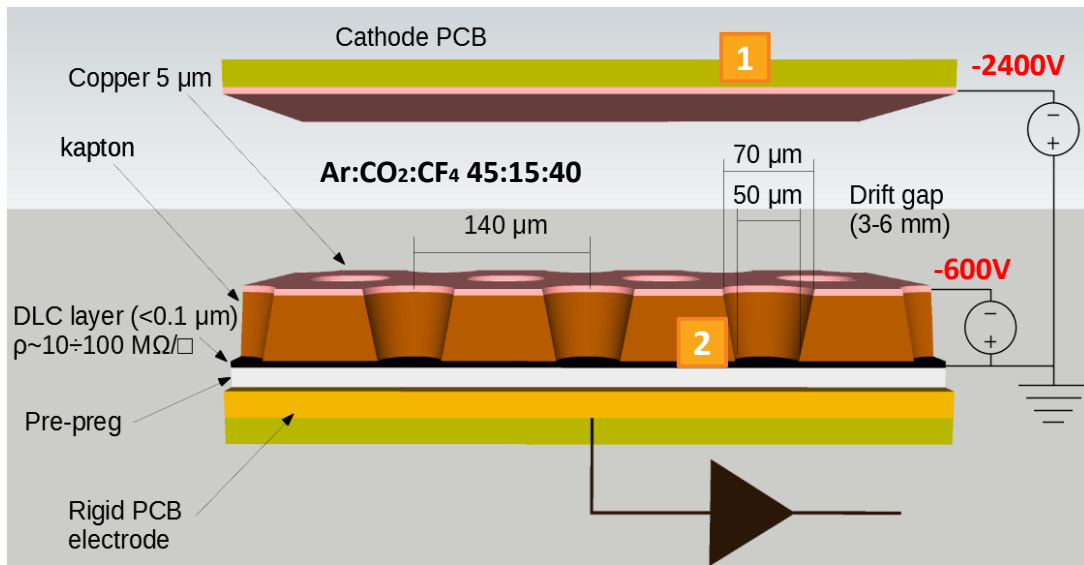
- In May 2023, MC simulations showed that the **tracking** configuration in the **endcap** regions of the ePIC detector, which will experience the **highest backgrounds** in the experiment, **would not provide enough hit points** in the $|\eta| > 2$ region for good pattern recognition.



ePIC tracker geometry before June 2023

- **Rate Capability**
 - Not critical ~ 1 kHz/cm² or less
- **Radiation Hardness**
 - Not critical for the detectors
 - Important for FEBs and RDO electronics boards
- **Temperature Stability**
 - Not critical for the detector performances
 - Detector calibration should consider gas pressure variations
- **Electronics power consumption and cooling**
 - SALSA ASIC consumption ~ 15 mW/channel at 1.2V $\rightarrow 60$ W/disk
 - Air vs liquid cooling is under study at Saclay





The μ -RWELL is a Resistive MPGD detector (Micro Pattern Gas Detector)

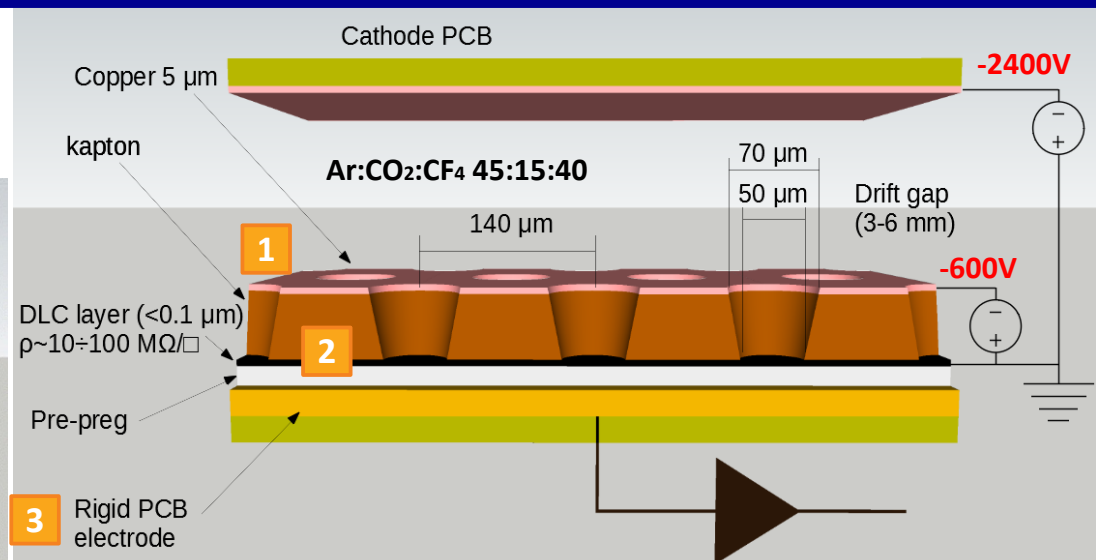
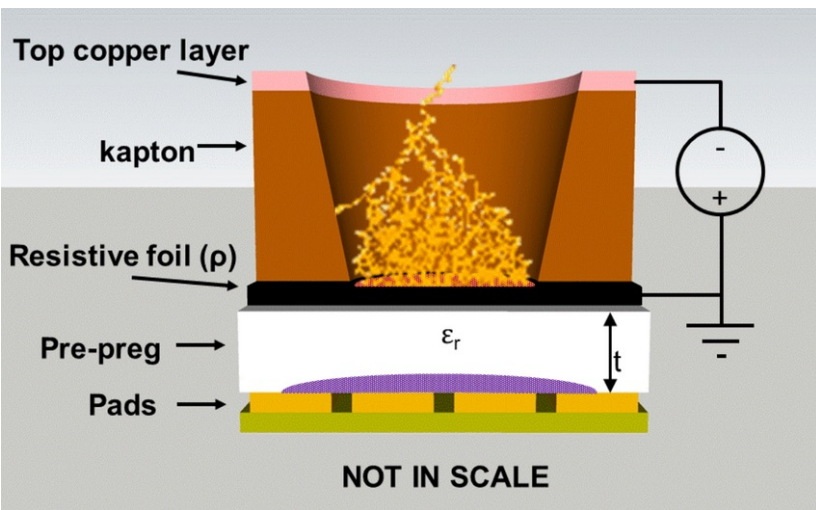
The device is composed of two elements:

- 1 drift/cathode PCB defining the gas gap ($5\mu\text{m}$ Cu layer on the bottom side)
- 2 μ -RWELL_PCB (detector core) Multilayer circuit: Well Pattered Polyimide \oplus resistive film \oplus readout PCB

Standard Gas mixture: Ar:CO₂:CF₄ 45:15:40 mixture (it also works with Ar:CO₂ «green» mixture)

Detector Technology Choices μ -RWELL

The core is the μ -RWELL_PCB, realized by coupling three different elements:



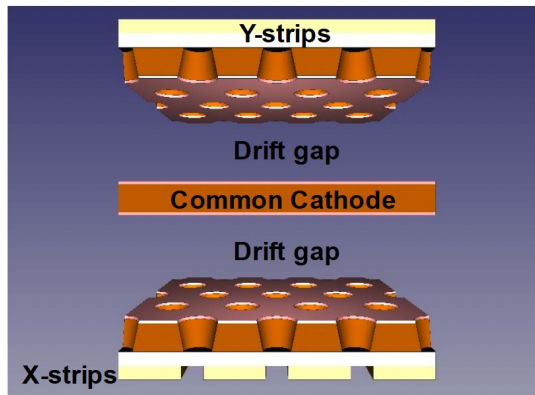
- 1 a WELL patterned kapton foil acting as amplification stage (GEM-like)
- 2 a resistive DLC layer (Diamond-Like-Carbon) for discharge suppression with surface resistivity $\sim 50 \div 100 \text{ M}\Omega/\square$
- 3 a standard readout PCB

Applying a suitable voltage between the **top Cu-layer** and the **DLC** the WELL acts as a **multiplication channel** for the **ionization** produced in the conversion/drift gas gap.

2-D Tracking layouts



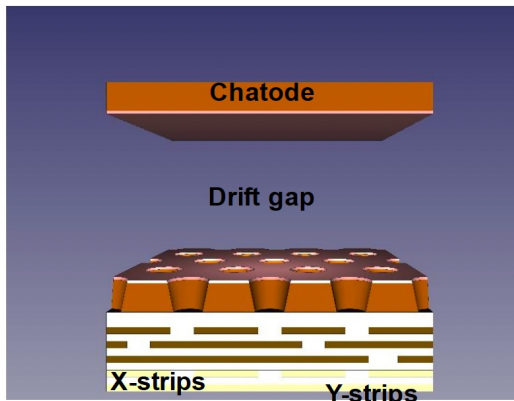
N.2 u-RWELLS 1D (2x1D)



October 2022 test beam

- 780 μm pitch
- 300 μm width
- 10 x 10 cm^2 active surface
- 128 channels

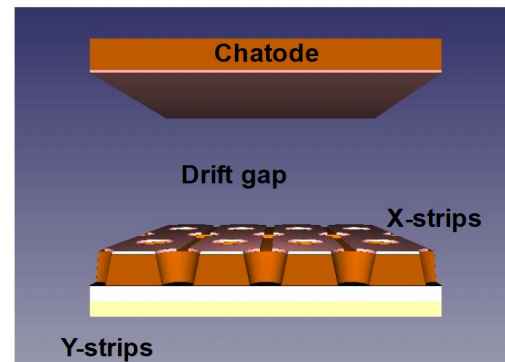
u-RWELL - Capacitive Sharing r/out



June 2023 test beam

- 1200 μm pitch
- 300 μm vs 1000 μm strips width
- 10 x 10 cm^2 active surface
- 83 channels
- “Compass-like” strip configuration
- Capacitive sharing

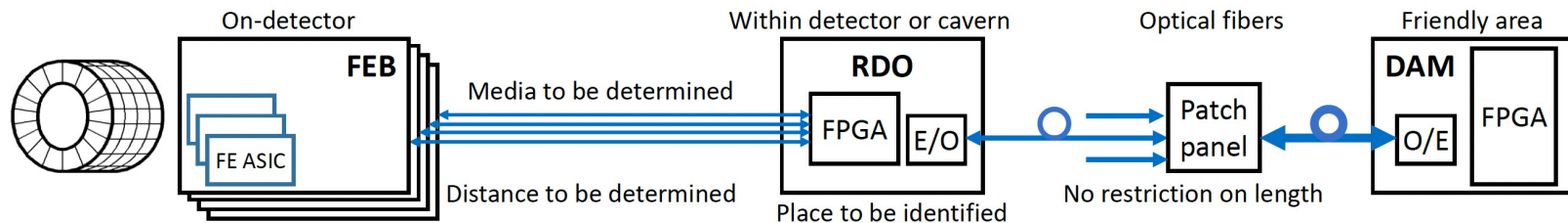
u-RWELL TOP r/out



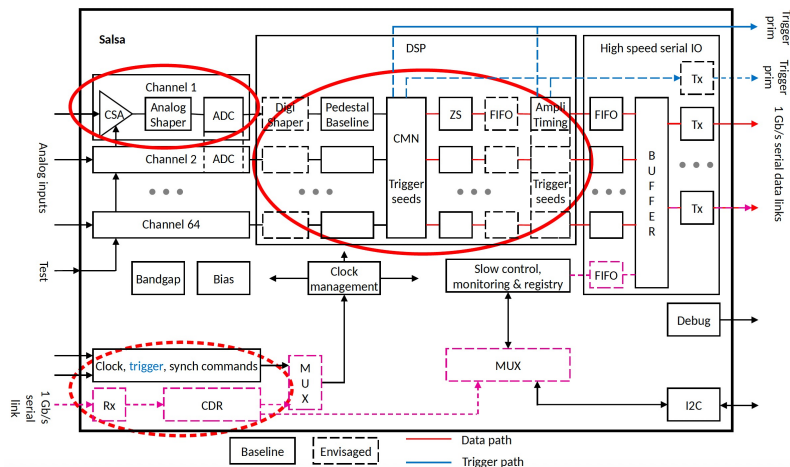
June 2023 test beam

- 780 μm pitch
- 300 μm width
- 10 x 10 cm^2 active surface
- 128 channels
- X-strips Top read-out
- Y-strips standard read-out

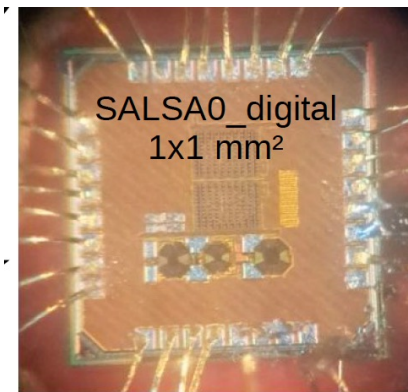
FEB – RDO – DAQ electronics



Preliminary design of SALSAs



- FEB is based on new **SALSAs** chip designed and produced by the **Saclay/San Paulo group** for all MPGD detectors
- Specific FEB form factor must be designed to fit each detector requirements



Roberto Ammendola
Paolo Musico

INFN Involvement timeline



August 2023: Interest of INFN groups to contribute to the MPGD trackers

- 1 year time to make the final decision about the INFN responsibility of the endcap construction
- Joined DRD-1 and eRD108 communities

December 2023: Direct contact with ePIC management (Rolf Ent)

- ePIC/DOE management agreed that INFN takes the leadership of MPGD ECT
- eRD108 → PED project: 30 k\$ from DOE to provide a design by the end of 2024.

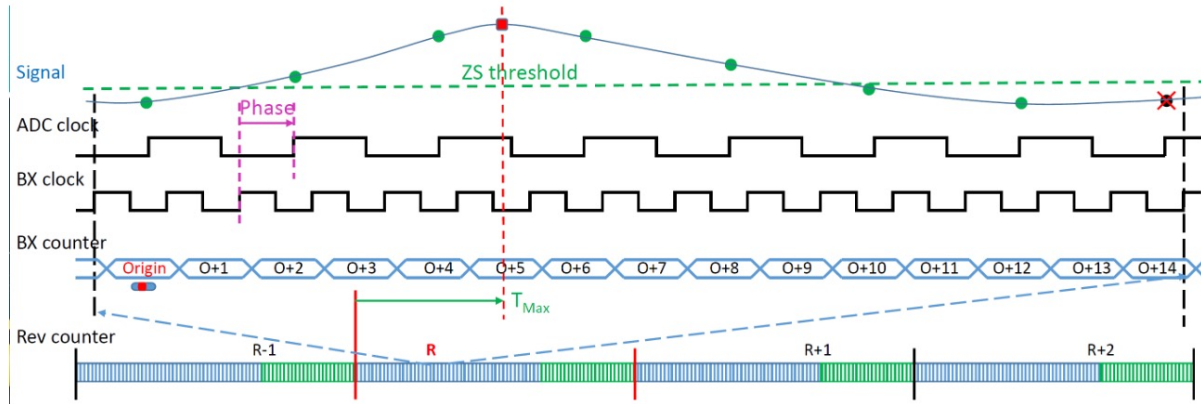
March 2024: Incremental Design and Safety Review (PDR)

- Detector technical choices and project design communicated to the management
- Very positive feedback

May 2024: MPGD ECT working group reinforced

- Interest expressed by Paolo Musico (INFN GE) and local RM TV digital electronic group to contribute to the FEB design
- Interest expressed by Temple University to contribute to the Lepton Disks construction
- **Support from the local INFN Director: electronics workshop and clean room**

Readout Strategies



- Signal is continuously sampled with an ADC
- Signal samples above threshold are retained
- Nominal (physics data) readout: signal amplitude and timing is derived → Time of max (as on example) or time of arrival (fitting samples on rising edge)
- On demand readout: signal shapes or raw non ZS data are provided → Calibration, detector studies
- Guarantees best noise immunity and thus best S/N ratio → Allows on line common mode noise (CMN) subtraction before ZS

EndCap Tracker Data Bandwidth Estimations

- Physics Data: support two zero suppression modes
 - Nominal: peak finding readout → 12 bit amplitude, 12 bit time of max, 8 bit ToT
 - On demand: full signal shape readout → All samples (12 bit) above threshold (typically 15-25 samples)
- Estimated Physics data bandwidth per Salsa ASIC with channel rate 10 kHz:
 - Peak finding 40 Mbit/s
 - Signal shape 265 Mbit/s
- On line calibration: on demand readout
 - Programmable number of non ZS samples
 - Estimated calibration data bandwidth per ASIC ~ 6 Mbit/s
- FEB RDO link occupancy: ~30 % of one 1 Gbit link
- Overall physics frontend data of ECT:
 - ~ 130 Gbit/s for on demand mode
 - ~ 37 Gbit/s for nominal mode

SALSA ASIC Characteristics

- Versatile front-end characteristics
 - Dedicated to MPGD detectors and beyond
 - 64 channels
 - Large range of peaking times: 50-500 ns
 - Large choice of gain ranges: 0-50, 0-250, 0-500 fC or 0-5 pC
 - Large range of input rates, up to 100 kHz/ch with fast CSA reset (limit assumed for EPIC: 25 kHz/ch)
 - Front-end elements can be by-passed
- Digital stage
 - Fast sampling ADC for each channel on 12 bits (\approx 10 effective bits) at up to 50 MS/s
 - Possibility under study to double rates by coupling pairs of channels
- Integrated DSP for internal data processing and size reduction, treatment processes to be selected according to user needs
 - Continuous readout compatible with streaming DAQ foreseen at EIC, triggered mode also available
 - Several 1 Gb/s output data links (will use one)
- General characteristics
 - \sim 1 cm² die size, implemented on modern TSMC 65nm technology
 - Low power consumption 15 mW/channel at 1.2V
 - Radiation hardened (SEU, TID)

The μ -RWELL (Micro Resistive Well Detector)

The μ -RWELL is a Resistive MPGD detector (Micro Pattern Gas Detector)

Used Gas : Ar:CO₂:CF₄ 45:15:40 mixture (it also works with Ar:CO₂ «green» mixture)

The device is composed of two elements:

- drift/cathode PCB defining the gas gap (5 μ m Cu layer on the bottom side)
- μ -RWELL_PCB (detector core)
 - Multilayer circuit: Well Pattered Polyimide \oplus resistive film \oplus readout PCB

Amplification stage: → 50 μ m thick Kapton (Apical®) foil

With a 5 μ m Cu layer on the top side

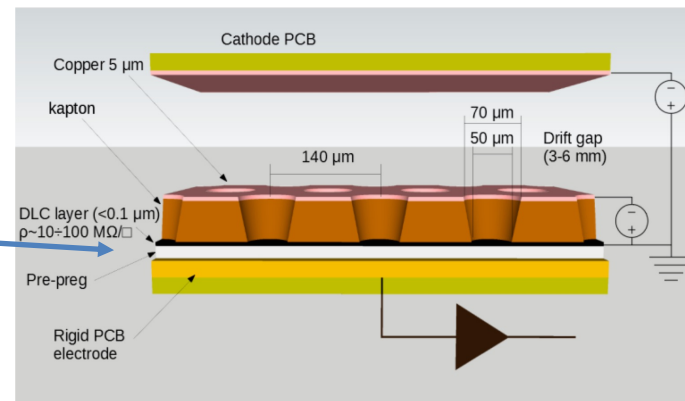
Resistive stage: → DLC (Diamond-Like-Carbon) film sputtered on the bottom side of the polyimide foil

Surface resistivity: $\rho = 10 \div 100 \text{ M}\Omega/\square$

↳ the resistivity is function of DLC thickness

The resistive layer strongly suppresses the transition from streamer to spark

⇒ Allows to achieve **large gains** ($> 10^4$), without affecting the capability to operate under **high particle fluxes**



G. Bencivenni et al.; 2015_JINST_10_P02008

The μ -RWELL principle of operation

The “WELL” acts as a multiplication channel for the ionization produced in the gas of the drift gap

The charge induced on the resistive layer is spread with a time constant:

$$\tau \sim \rho \times c$$

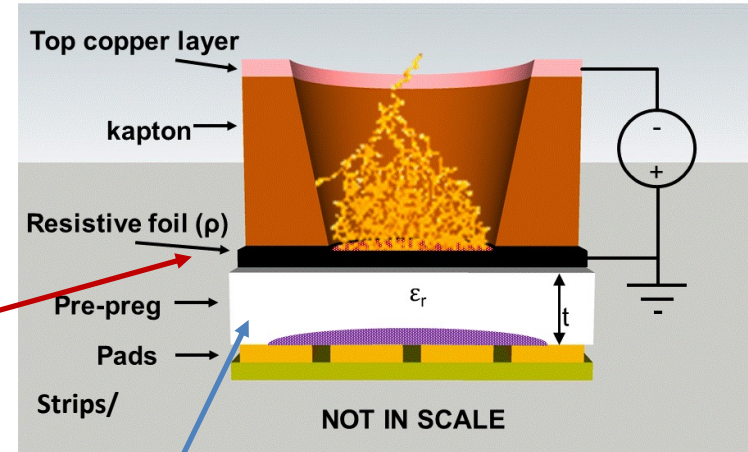
[M.S. Dixit et al., NIMA 566 (2006) 281]:

ρ → the DLC surface resistivity

c → the capacitance (per unit area), depending on the distance between the DLC and the readout plane

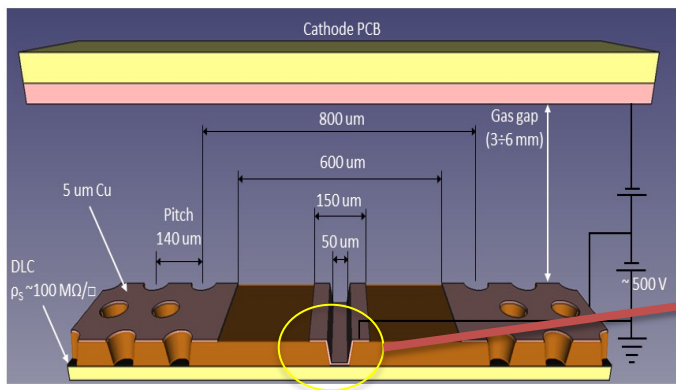
$$C = \varepsilon_0 \times \varepsilon_r \times \frac{S}{t} = 120 \text{ pF} \times L(m) \quad - \quad w=0.2 \text{ mm}, \quad p=0.4 \text{ mm} \text{ strip read-out}$$

- The resistive stage ensures the quenching of the spark amplitude
- As a *drawback*, the capability to stand high particle fluxes is reduced, but appropriate grounding schemes of the resistive layer solves this problem

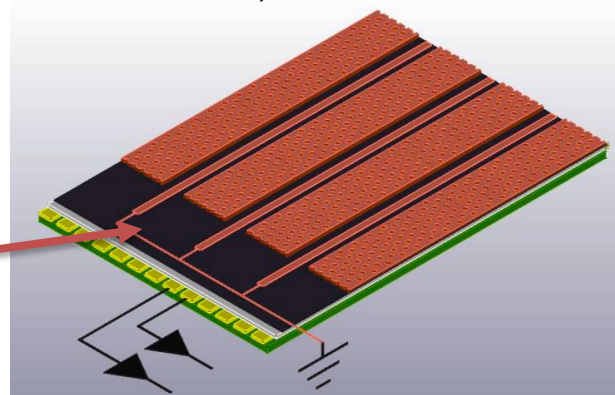


Studies have been focused on the DLC grounding layout to increase the rate capability while maintaining a safe resistivity \Rightarrow The solution is to reduce as much as possible the current path towards the ground connection introducing a high density “**grounding network**” on the resistive stage of the detector

PEP – Patterning-Etching-plating



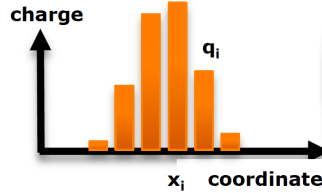
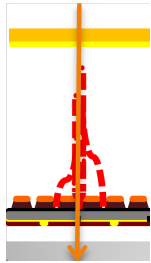
*The micro-RWELL layouts for high particle rate,
G.Bencivenni et al., 2019-JINST-14-P05014*



The active area is discontinued by grooves that uncover the DLC; then a copper plating, carefully separated from the copper in the active sectors, is disposed to connect the DLC to the ground.

A small dead zone on the amplification stage must be introduced for high stability operation

The μ -RWELL Technology

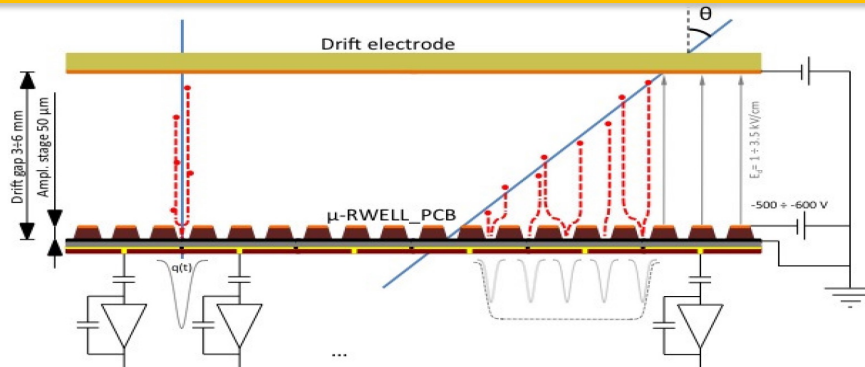


$$x_{hit} = \frac{\sum x_i \cdot q_i}{Q_{tot}}$$

Charge Centroid reconstruction method

The track position is determined as a weighted average of fired strips

GOOD FOR ORTHOGONAL TRACKS



FOR INCLINED TRACKS &/or HIGH B FIELD

the Charge Centroid method gives a **very broad spatial distribution** on the anode-strip plane.

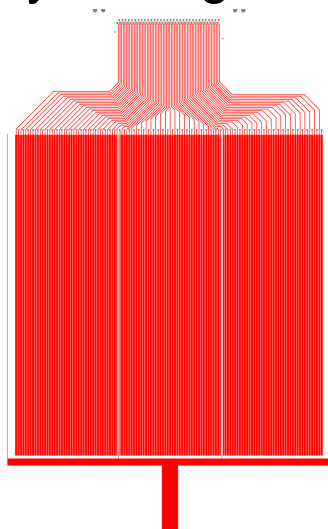
μ TPC reconstruction

The spatial resolution is strongly dependent on the impinging angle of the track → A non-uniform resolution in the solid angle covered by the apparatus → Large systematical errors.

2D – readout: step by step approach

1. The first prototype was a set of 2x1D detectors each having the following specs, rotated by 90 degrees:

- 780 μm pitch
- 300 μm width
- 10 x 10 cm^2 active surface
- 128 channels



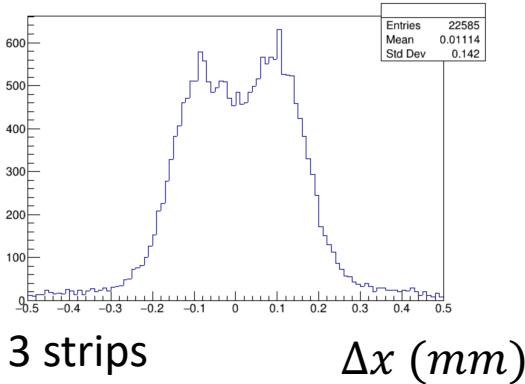
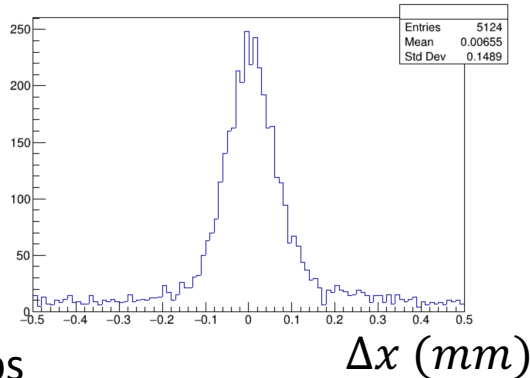
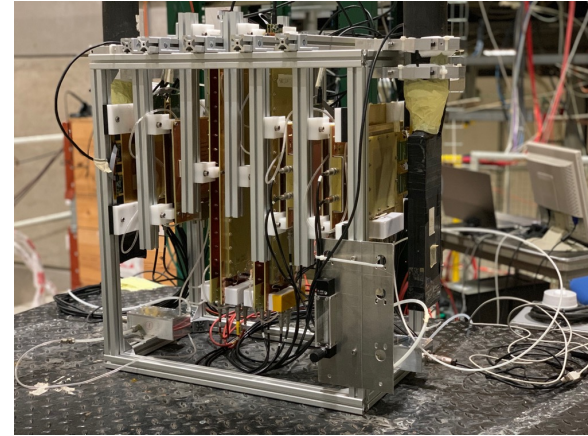
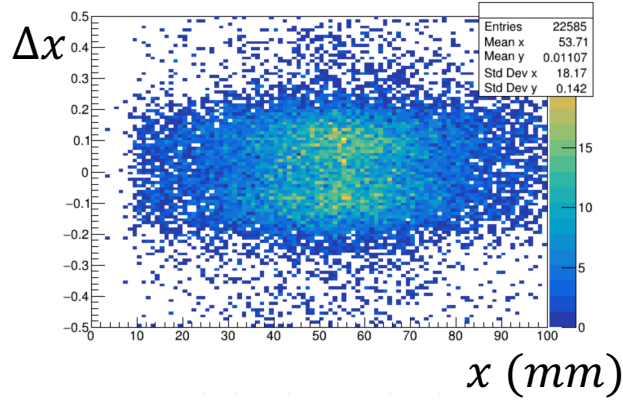
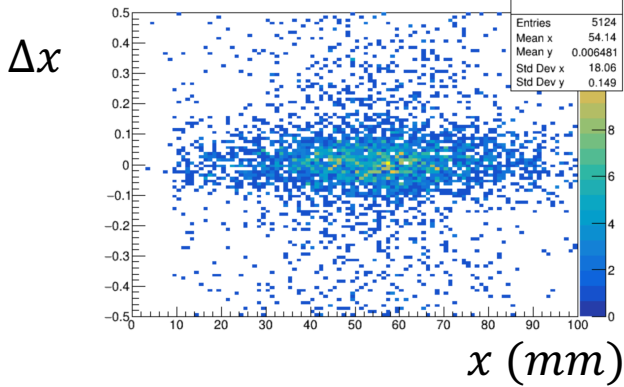
5 – 19 October 2022



Test Beam: SPS North Area H8

2D Readout Scheme

2D – readout: 780 μm pitch-300 μm width - 10 x 10 cm^2 active surface



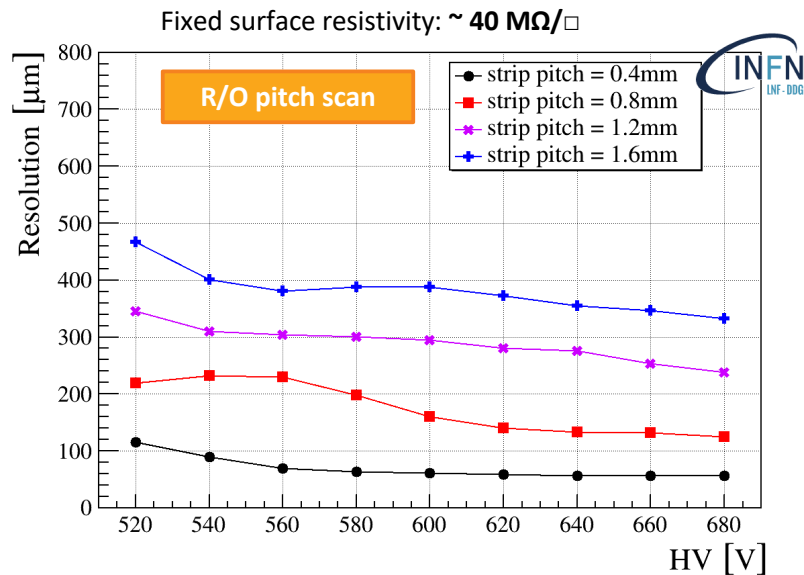
Increasing the pitch read-out the resolution is strongly affected by the number of strips among which the charge is distributed

2D – readout: step by step approach

1. 2x1D detectors.

The 2022/2023 tests show that the optimal pitch to obtain $100 \mu m$ resolution is the following:

- **400 μm pitch**
- **300 μm width**

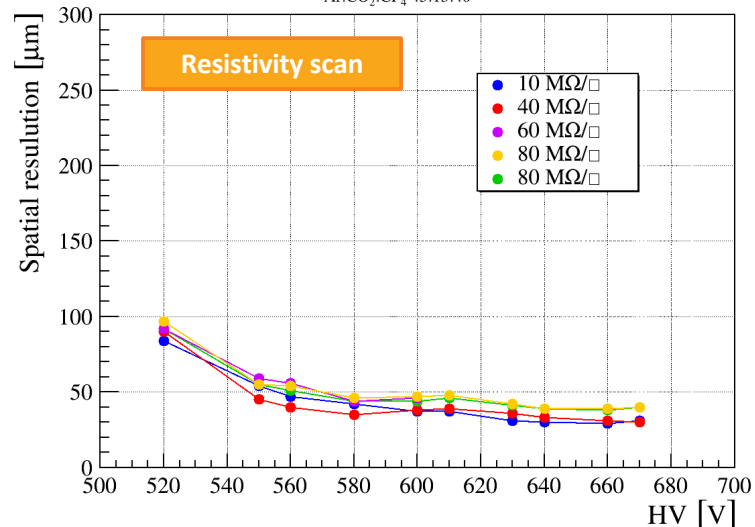


Increase the R/O pitch

=

As expected: reduction of the space resolution.

RD-FCC μ -RWELL, Residuals test resolution - 75ADC threshold
Ar:CO₂:CF₄ 45:15:40



Fixed strip pitch (0.4 mm) and width (0.15 mm)

No effects in **this resistivity range**.

→ DLC resistivity uniformity is not a crucial parameter for space resolution

2D Readout Scheme

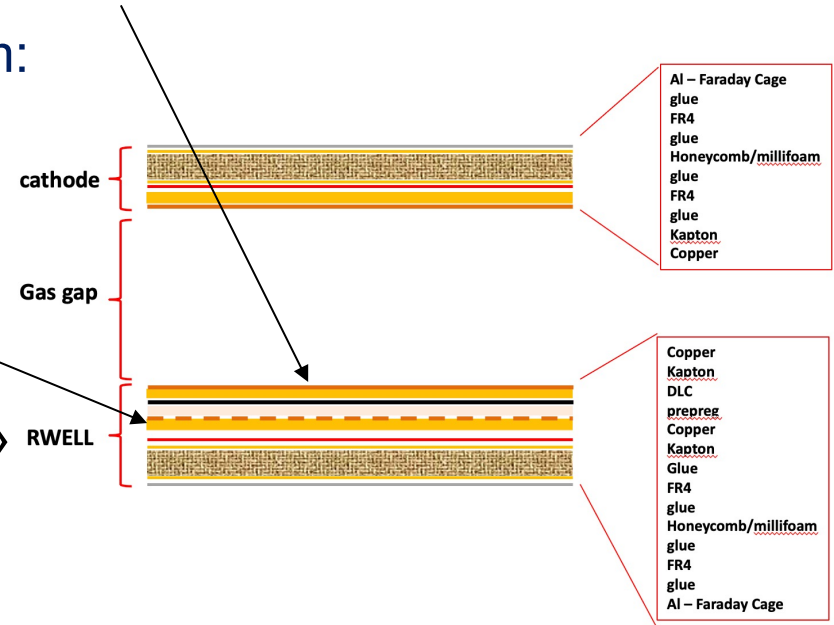
2D – readout: step by step approach

2. The second prototype reads the 2-nd coordinate on the “top” copper layer

Same readout geometry as in the bottom:

- 780 μm pitch
- 300 μm width
- 10 x 10 cm^2 active surface
- 128 channels

The effect charge collection on the «top» layer is the object of investigation.

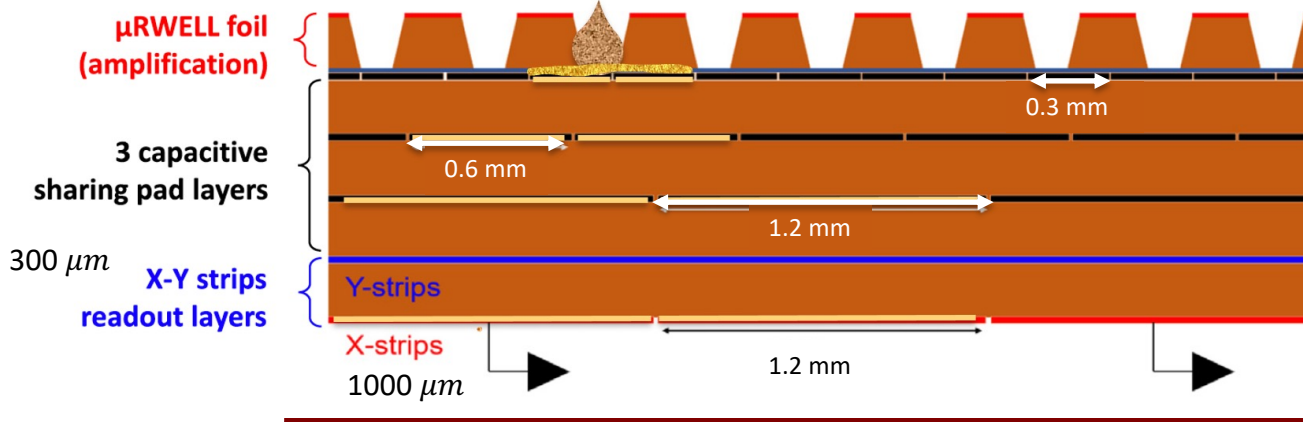
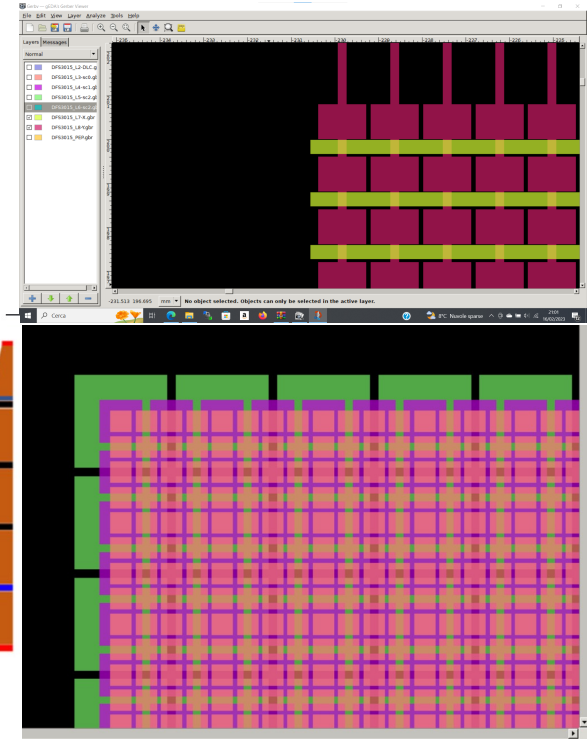


2D Readout Scheme

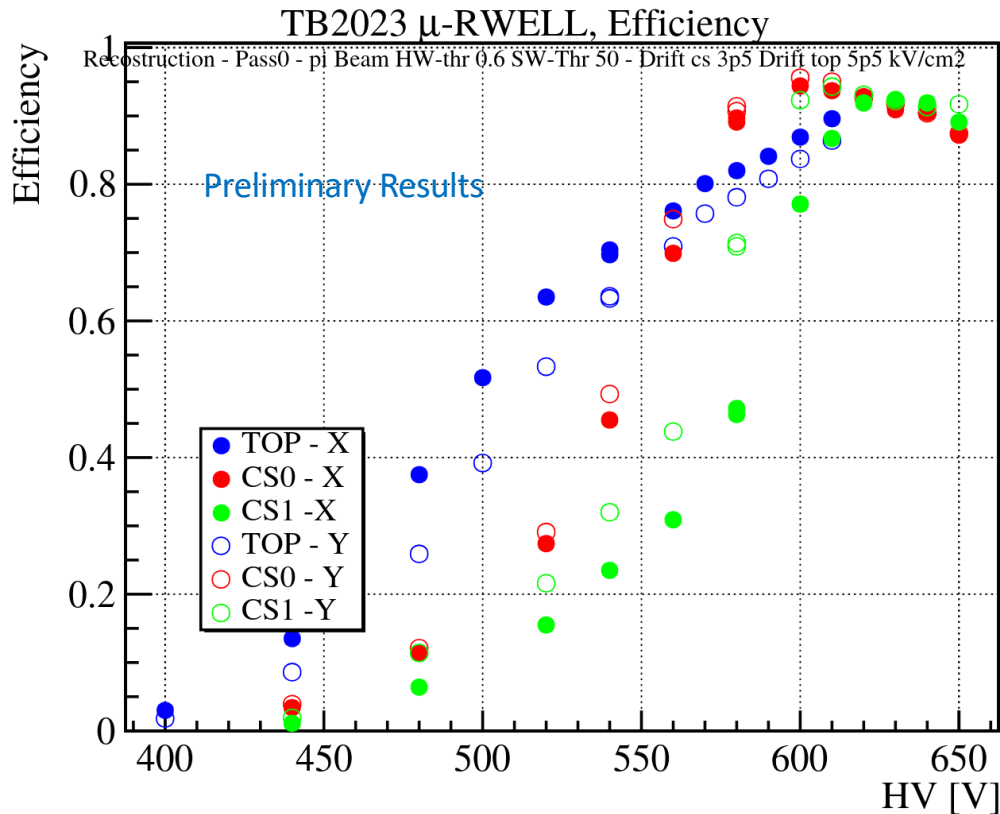
2D – readout: step by step approach

3. The third prototype reads both coordinates on the bottom in “COMPASS-like” strips configuration with capacity sharing read-out:

- 1200 μm pitch
- 300 μm vs 1000 μm strips width
- 10 x 10 cm^2 active surface
- 83 channels

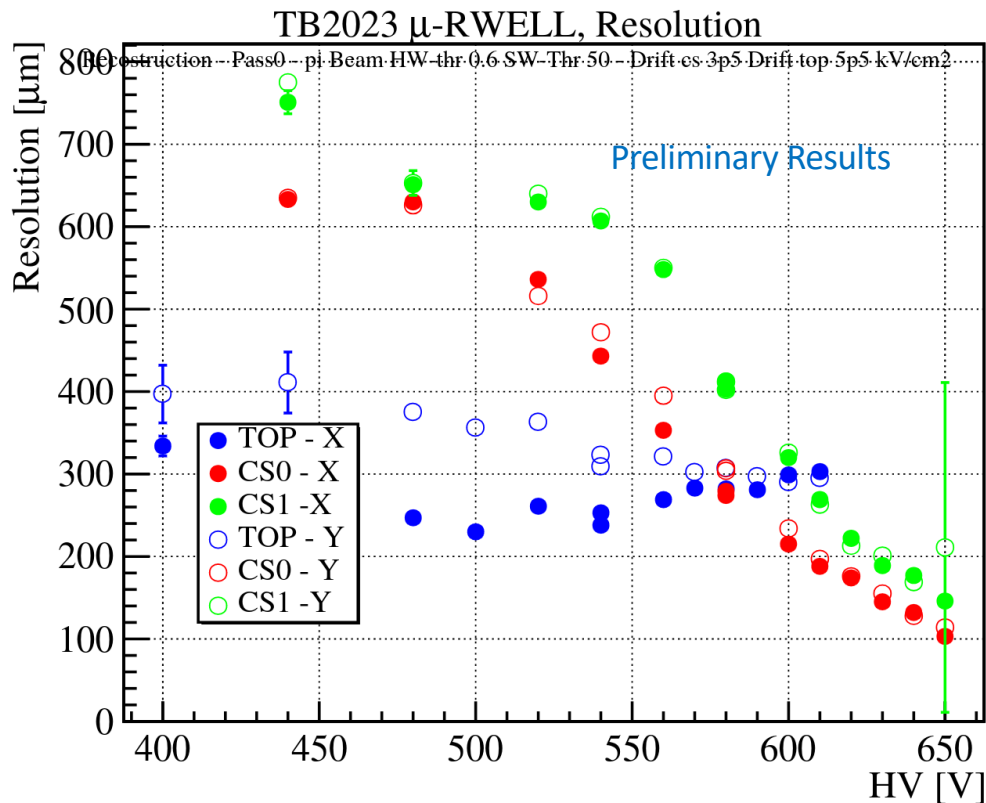


Preliminary results from June test beam



Efficiency

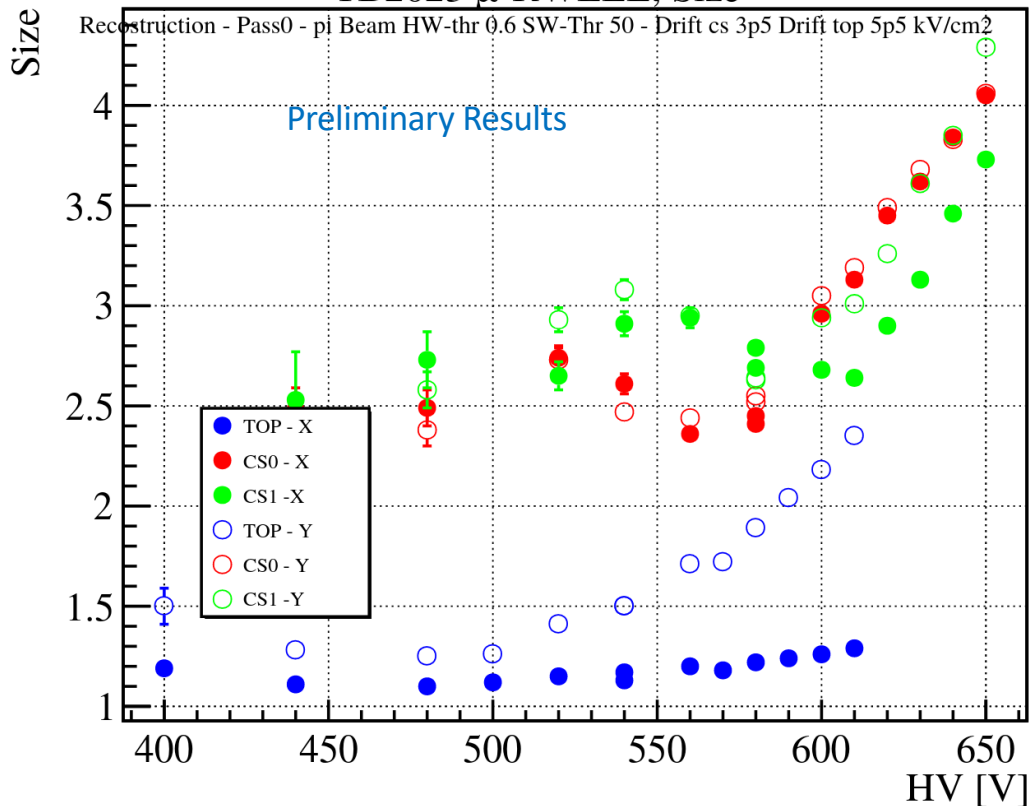
- CS readout reaches a plateau at higher HV values than standard readout scheme.
- TOP readout is not yet at plateau at 600 V (HV was chosen not to be raised to higher values)



Resolution

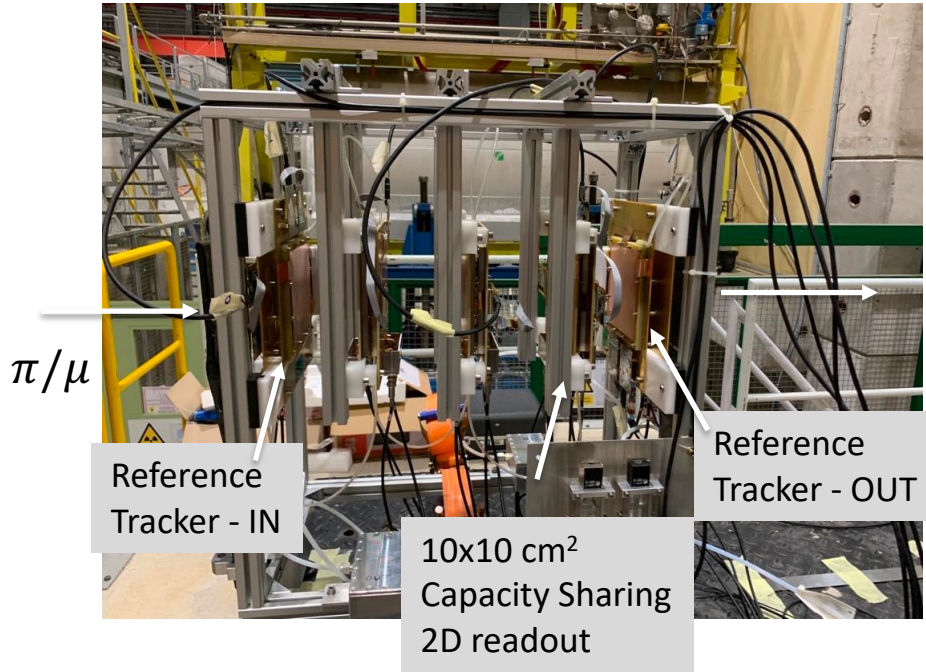
- CS readout reaches $100 \mu\text{m}$ resolution at highest HV values (starting from $1200 \mu\text{m}$ pitch)
- TOP readout resolution is fixed at $250\text{-}300 \mu\text{m}$ (pitch is $780 \mu\text{m}$)

TB2023 μ -RWELL, Size



Cluster Size

- CS readout Cluster Size is not lower than 2.5 strips and increases to 4 at higher HV.
- higher cluster size \rightarrow better resolution
- TOP readout cluster size is fixed at 1.3
- Bottom readout cluster size increases from 1.5 to 2.3 with HV



TEST BEAM at CERN SPS North Area H8:
16 - 30 October 2024

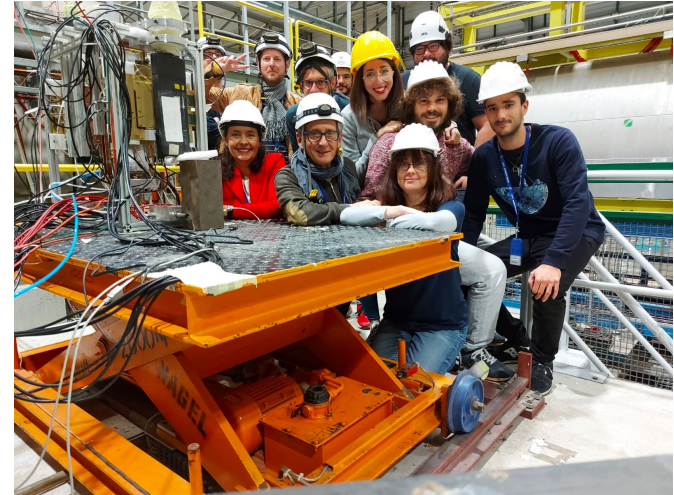


Photo taken during 5 – 19 October 2022 test beam

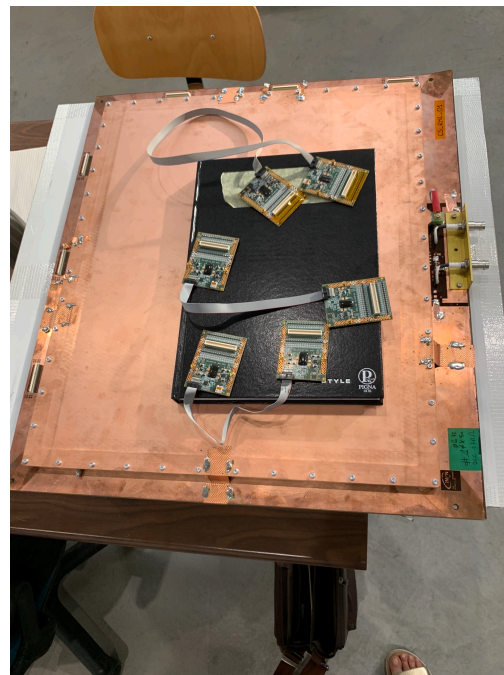
First Large Area Detector prototype

A first large area $40 \times 46 \text{ cm}^2$ detector has been delivered to Roma Tor Vergata and is being characterized in collaboration with the LNF group lead by Gianni Bencivenni

$1200 \mu\text{m}$ pitch

$300 \mu\text{m}$ vs $1000 \mu\text{m}$ strips

6 mm gas gap



Studies have been focused on the DLC grounding layout to increase the rate capability while maintaining a safe resistivity \Rightarrow The solution is to reduce as much as possible the current path towards the ground connection introducing a high density “grounding network” on the resistive stage of the detector

2015

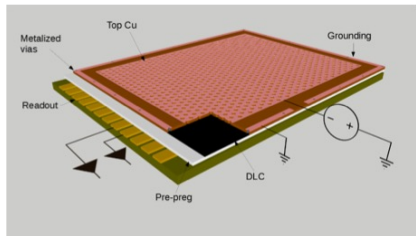
2017

2018

2020

time \rightarrow

R&D on low-rate layout



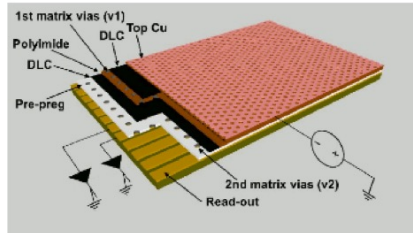
SRL_Single-Resistive-Layer

the DLC grounding is provided all around the active area.

detection efficiency:

$$\frac{G}{G_0} \sim 1 \text{ up to } 35 \text{ kHz/cm}^2$$

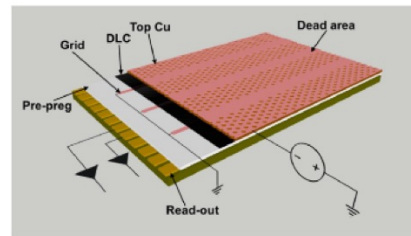
R&D on high-rate layout (*grounding network also in the active area*)



DRL-DoubleResistive Layer

Two DLC layers connected by a matrix of conductive vias and grounded by a further matrix of vias to the readout electrodes

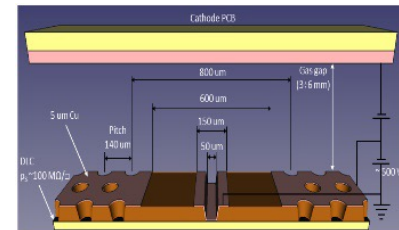
$$\frac{G}{G_0} > 0.90 \text{ up to } 3\text{MHz/cm}^2$$



SG –Silver Grid

a SRL with a 2-D grounding conductive strip lines realized on the DLC layer.

$$\frac{G}{G_0} > 0.90 \text{ up to } 20\text{MHz/cm}^2$$



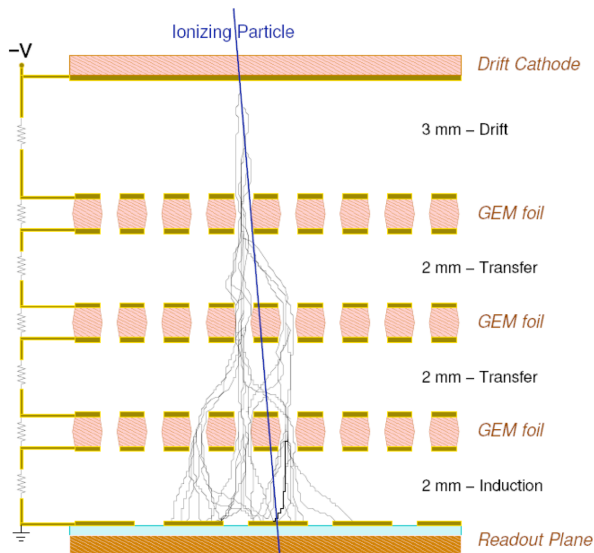
PEP-Patterning-Etching-plating

*the grounding grid of the DLC is patterned by **etching a groove in the base material from the top***

$$\frac{G}{G_0} > 0.90 \text{ up to } 20\text{MHz/cm}^2$$

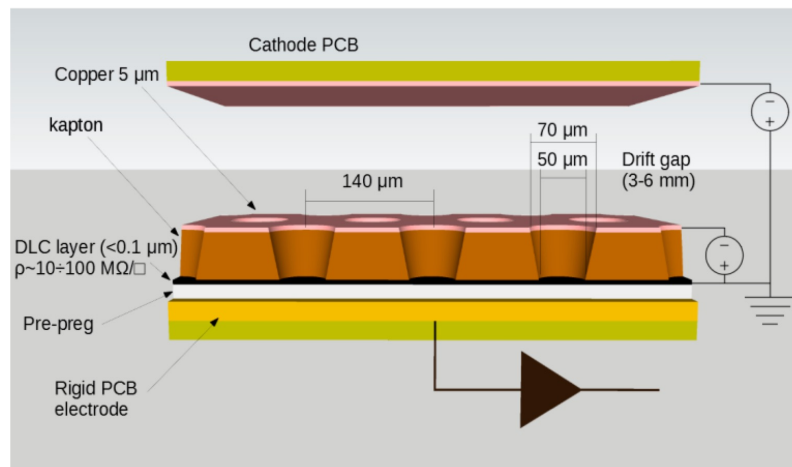
Two MPGD detector technologies have been discussed, triple-GEM and μ -RWELL

- Large area triple-GEM detectors have been used in experiments (PRad, SBS, ...).



F. Sauli, Nucl. Instr. and Meth. A386 (1997) 531

- μ -RWELL technology is new, only small prototypes have been tested:
 - will require extensive R&D.
- μ -RWELL detector is best suited for CLAS12:
 - low material budget, easy to build, less support structures in the active volume of the detector.

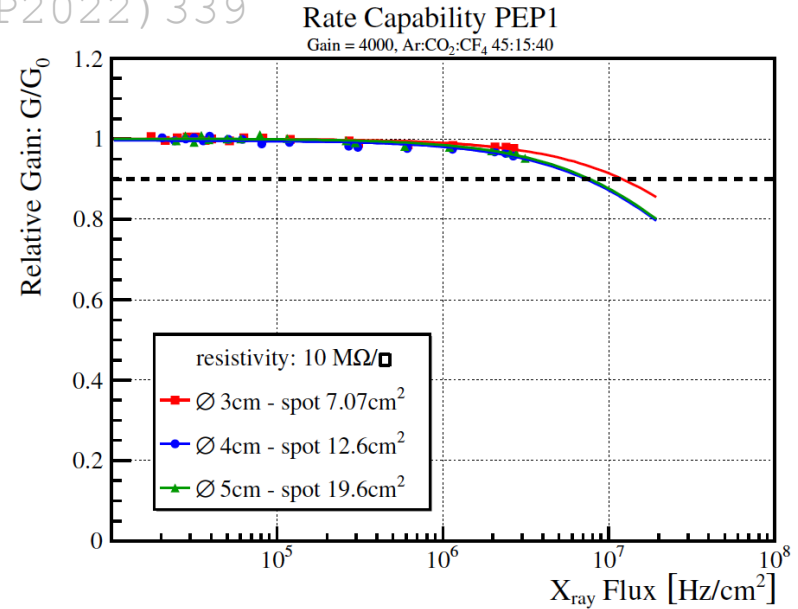
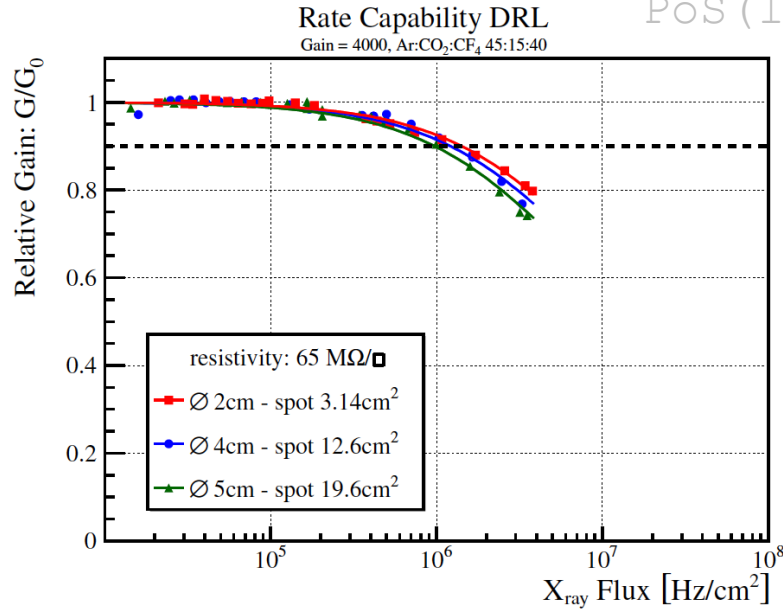


G. Bencivenni et al.; 2015_JINST_10_P02008

The High-Rate solution: PEP



POs (ICHEP2022) 339

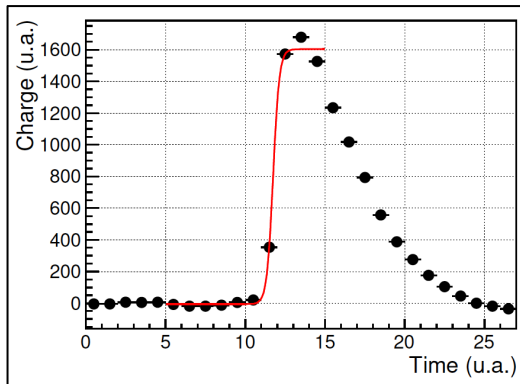


Rate capability measured with 5.9 keV X-rays with Double Layer μ -RWELL (DRL) and with PEP

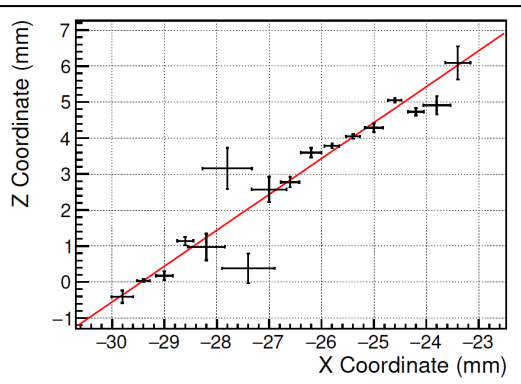
NB: a photon flux around $1 \text{ MHz}/\text{cm}^2$, which corresponds to a m.i.p. rate of $3 \text{ MHz}/\text{cm}^2$.

A possible solution : μ TPC reconstruction

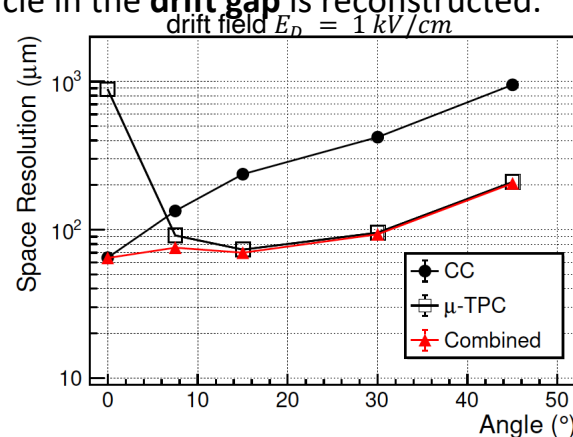
- The electrons created by the ionizing particle drift towards the amplification region
- In the μ TPC mode from the **knowledge of the drift time** and the **measurement of the arrival time of electrons**, the **track segment in the gas gap is reconstructed**
- The **fit of the analog signal** gives the **arrival time of drifting electrons**.
- By the knowledge of **the drift velocity**, the 3D trajectory of the ionizing particle in the **drift gap** is reconstructed.



Integrated charge as a function of the sampling time



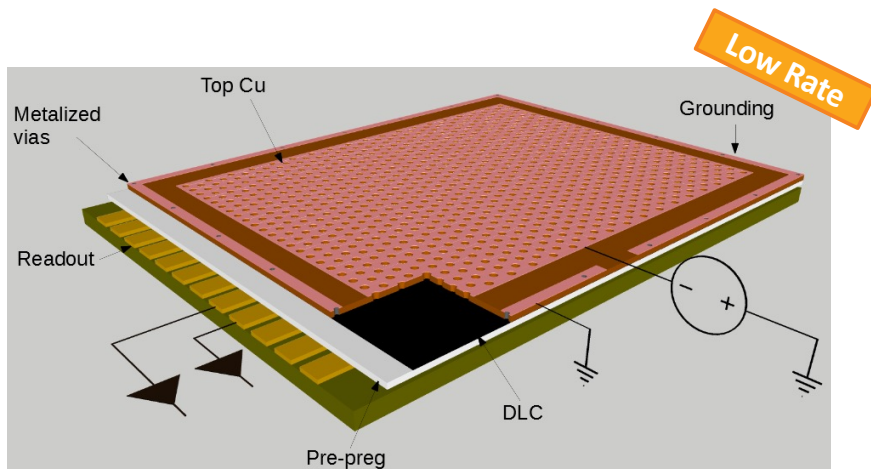
Example of a track reconstruction using the TPC algorithm.



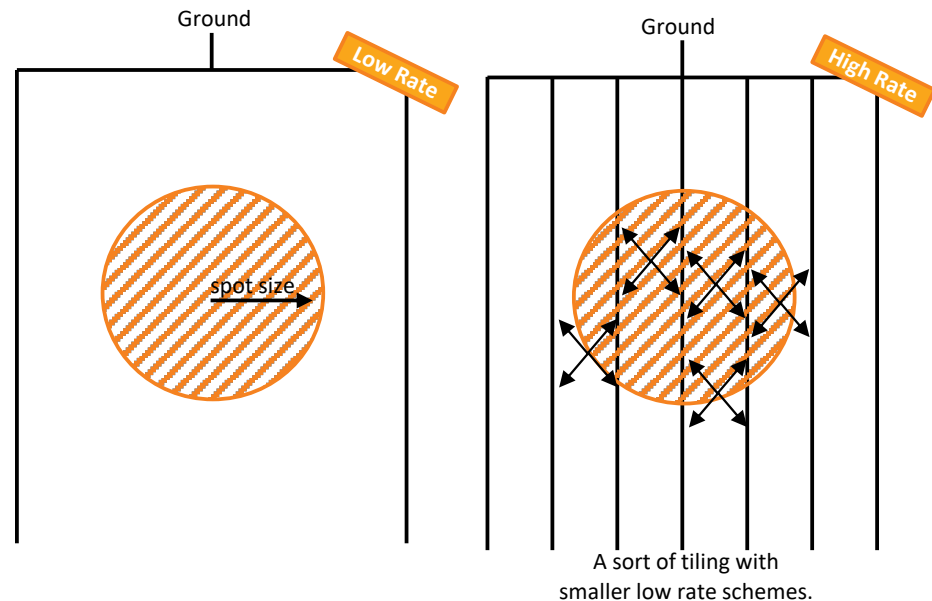
Comparison of the **CC** and μ TPC reconstruction algorithms in function of the impinging angle

The μ -RWELL – High Rate scheme

To overcome **the intrinsic rate limitation** of the Single Resistive layout: introduction of an **high density “grounding network”**.



Single Resistive Layout (SRL)



Spot Effect for SRL – Manufacturer plot

SRL: Rate Capability vs Spot

Gain = 4000, Ar:CO₂:CF₄ 45:15:40

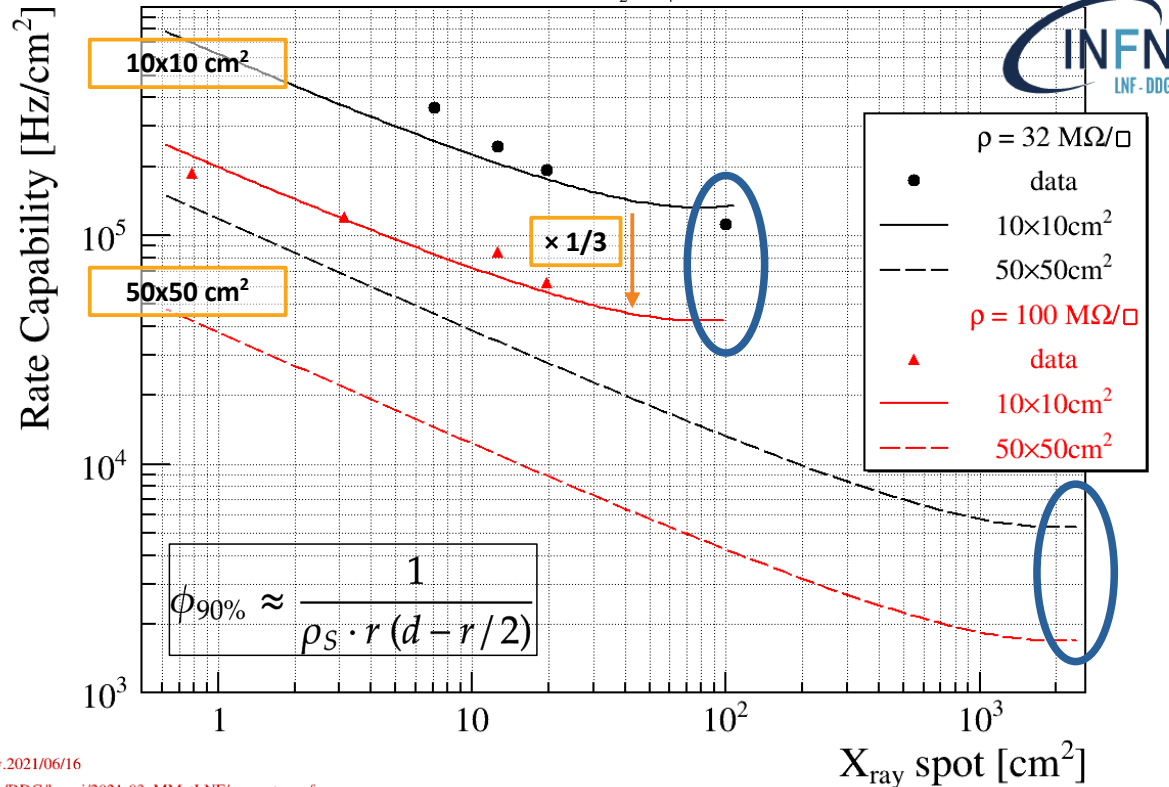
From the mathematical model:

1. detectors with same size but **different resistivity** exhibit a rate capability scaling as the inverse of their resistivity:

$\times 1/3$

2. for the SRL, **increasing the active area** from 10×10 cm² to 50×50 cm² the rate capability should go down to few kHz/cm²

3. thus using a DLC **ground sectoring** every 10/20/30 cm, detectors could achieve rate capability up to 100kHz/cm² (with X-ray)



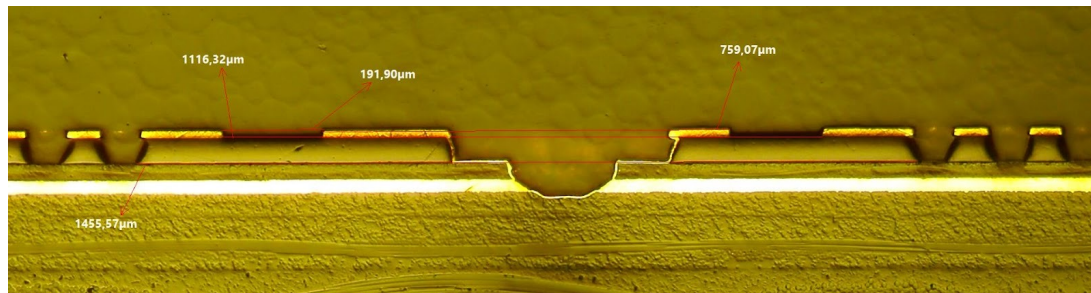
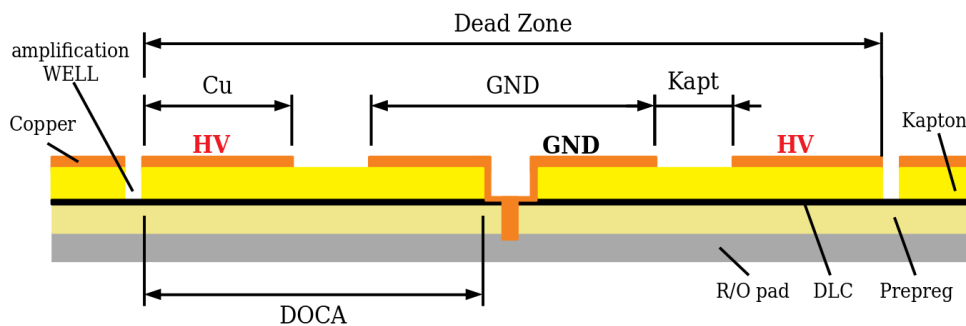
Different primary ionization ⇒
Rate Cap._{m.i.p.} = 3×Rate Cap._{X-ray}

v.2021/06/16

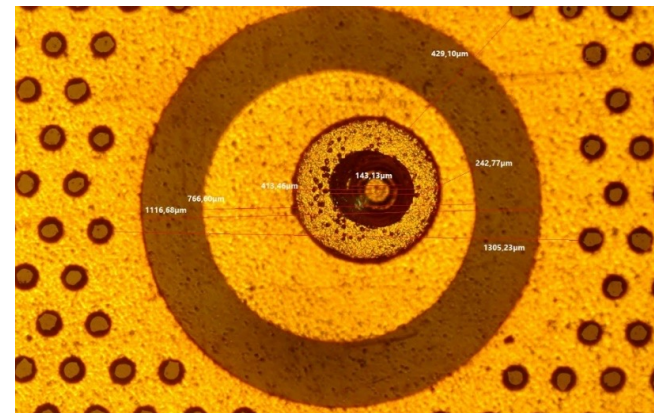
~/DDG/lavori/2021-03_MMATLNF/rc_spot_conf

The PEP-dot μ -RWELL

DLC-GND pitch [mm]	Dead Zone [mm]	GND width [mm]	Insulation gap [mm]	DOCA [mm]
9	1.1 (2%)	0.6	0.25	0.7



- The most recent high rate layout
 - Patterning–Etching–Plating
- The DLC ground connection is established by creating **metallized vias from the top Cu layer through the DLC**, down to the pad-readout of the PCB
- The dead zone is $\sim 2\%$



PEP-dot – results

